



**KOREA**  
UNIVERSITY

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# **Road to Build Radiation Detector and Imager**

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**I . Definition of Radiation,  
Radiation Detection and Measurement**

**II. Important factors to Build Radiation Devices**

**III. Researches for Radiation Devices in Korea**

**IV. Researches of Our (RMI) Lab. in Korea University**

**V. Conclusion and Discussion**

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# Definition

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# Definitions

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## What is Radiation?

**“Particle or wave transmitting in space.”**

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# Definitions

**Particle** or wave transmitting in space."

A stone is a particle....., But a Radiation ?

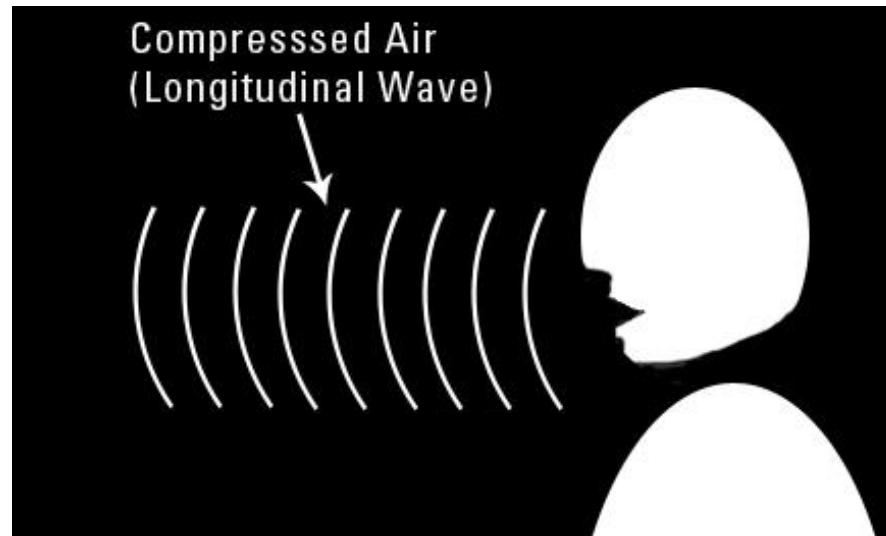


No! It should be subatomic.

# Definitions

“Particle or **wave** transmitting in space.”

Sound is a kind of waves....., But a Radiation ?



No! It cannot transmit in vacuum.



# Definitions

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**“Subatomic particle or wave transmitting in space including vacuum.”**

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## What is Detection?

**“Extraction of particular information from a larger stream of information without specific cooperation from or synchronization with the sender”**

**Then, What is Radiation Detection?**

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# Definitions

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## What is Measurement?

**“Assignment of numbers to objects or events”**

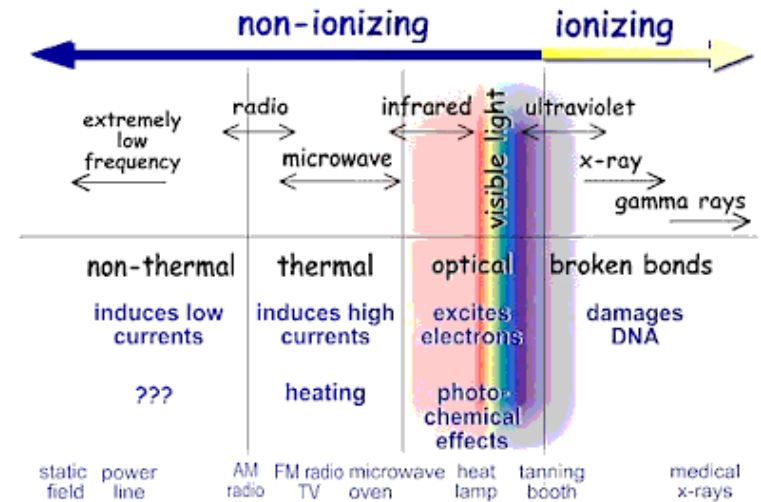
**Then, What is Radiation Measurement?**

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# How to Detect

Can you see radiation?

If not, how to see?



## Make the Invisible Radiations to Visible

- Convert to **electron** and measure by electronics
- Convert to **light** and measure (or see) it
- Changed Chemical property (**Color**)
- Miscellaneous (**Temperature, Damage, Fission**)

# How to Detect

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## 1. Convert to **electron** and measure by electronics

- . Gas: ionization chamber, proportional and GM tube
- . Solid: Semiconductor, Scintillator (?)

## 2. Convert to **light** and measure (or see) it

- . Gas, Liquid, Solid: Scintillator, TLD

## 3. Measure change in **chemical** property (color)

- . Liquid: Fricke and cerium dosimeter
- . Solid: Glass dosimeter, X-ray film

## 4. Miscellaneous

- . Cerenkov\*, Fission chamber, Damage, Superconductor
-

# Measurement



1D



2D

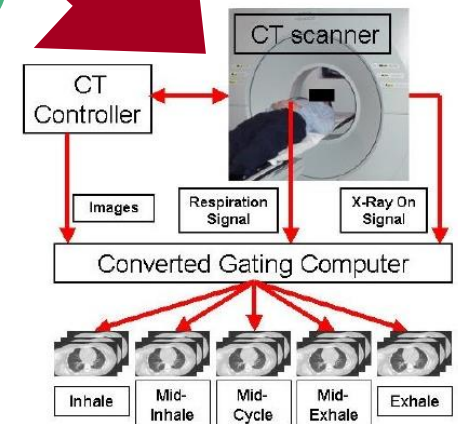
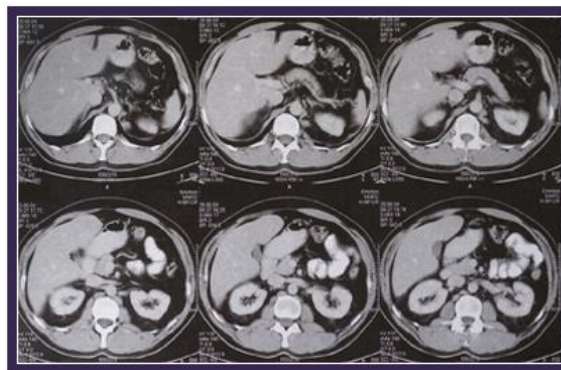


**0 dimension**  
(Detector, Statistics)

4D



3D

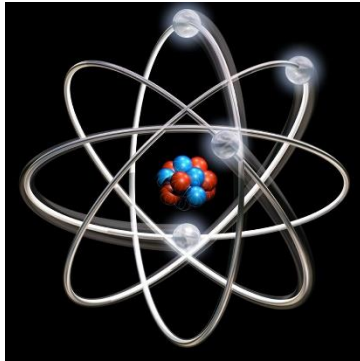




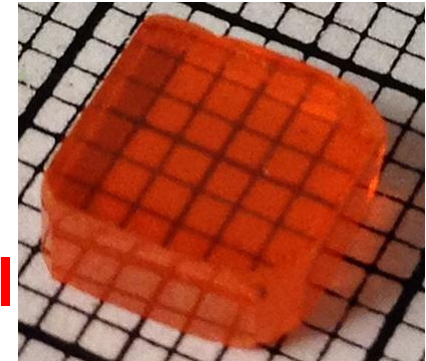
# Important Factors to Build Radiation Devices

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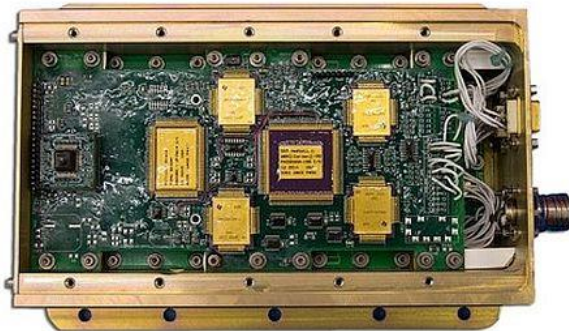
# Important Factors to Build Radiation Devices



**Physics**

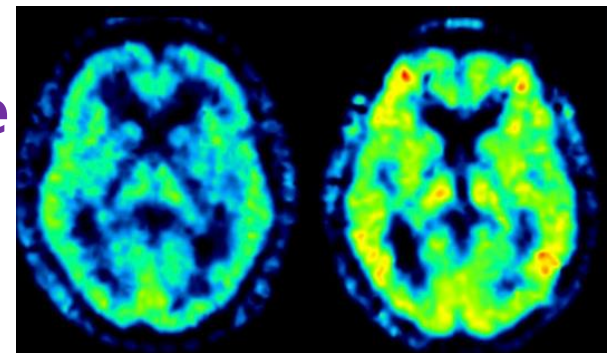


**Material**



**Electronics**

**Software**



# Important Factors to Build Radiation Devices

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**Physics: Relatively Well known**

**Detector Material: Needs Time and Technique**

**Software: Commercially wide spread**

**Electronics: Commercial Devices but ASIC is unique skill**

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# Important Factors to Build Radiation Devices

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## Material

- . Purity of Base Material (CdZnTe from Battery industry)
- . Property of Tools such as glass tubes
- . High performance of Devices -> Cost
- . **Time and Labor intensive** (Find the Best conditions)
- . **Not only Idea but Technique** (Sealing, Remove impurity)

## Electronics

- . Many Commercial Devices
  - . Many Custom-made-electronics applied for PMT, SiPM
  - . **Only a few ASIC to process a number of small signals**  
**Laborious and Limited Market (IDEAS, BNL, Kromek...)**
-





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# Researches for Radiation Devices in KOREA

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# Discovery of Tl based scintillators

KNU group started a pioneer work in 2009 on Tl-based high-Z compounds and published  $\text{Tl}_2\text{LiGdCl}_6:\text{Ce}^{3+}$  paper as a first Tl-based scintillator in 2015 and presented  $\text{Tl}_2\text{LiYCl}_6:\text{Ce}^{3+}$  SCINT2015.



- $\text{Tl}_2\text{LiGdCl}_6:\text{Ce}^{3+}$  [1]
- $\text{Tl}_2\text{LiGdBr}_6:\text{Ce}^{3+}$  [2]
- $\text{Tl}_2\text{LiYCl}_6:\text{Ce}^{3+}$  [3,4]
- $\text{Tl}_2\text{LiLuCl}_6:\text{Ce}^{3+}$  [5]
- $\text{Tl}_2\text{LiScCl}_6:\text{Pure}$

- $\text{Tl}_2\text{LaCl}_5:\text{Ce}^{3+}$  [7]
- $\text{Tl}_2\text{LaBr}_5:\text{Ce}^{3+}$  [8]
- $\text{Tl}_2\text{GdCl}_5:\text{Ce}^{3+}$  [9]
- $\text{TlGd}_2\text{Cl}_7:\text{Ce}^{3+}$  [10]

- $\text{TlSr}_2\text{Br}_5:\text{Pure}$  [11]
- $\text{TlCaCl}_3:\text{Pure}$  [12]
- $\text{TlSr}_2\text{I}_5:\text{Eu}^{2+}$  [13]

[11] G. Rooh et al., Opt. Mater., 73 (2017) 523.

[12] A. Khan et al., Rad. Measurement., 107 (2017) 115.

[13] H.J. Kim et al., Opt. Mater., 82 (2018) 8

[1] H.J. Kim et al., J. Lumin., 164 (2015) 86–89.

[2] H. J. Kim et al., Rad. Measurement., 90 (2016) 279-281.

[3] H. J. Kim et al., IEEE Trans. Nucl. Sci., 63 (2) (2016) 439.

[4] G. Rooh et al., J. Cryst. Growth, 459 (2017) 163–166.

[5] G. Rooh et al., J. Lumin., 187 (2017) 347–351.

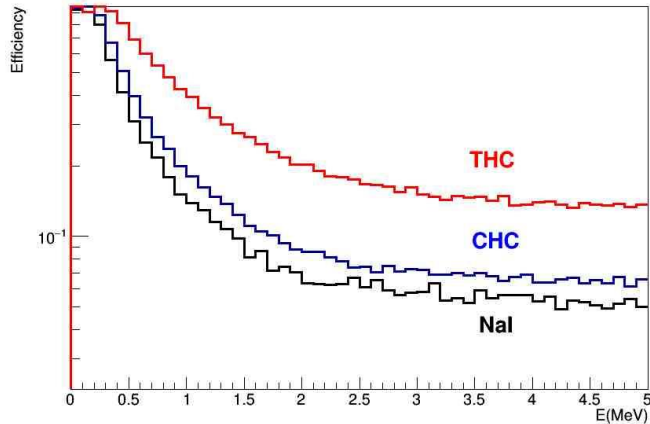
[7] H.J. Kim et al., J. Lumin., 186 (2017) 219–222.

[8] H.J. Kim et al., NIMA., 849 (2017) 72–75.

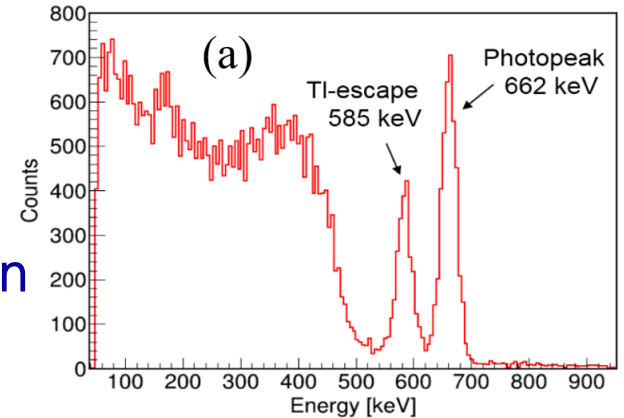
[9] G. Rooh et al., IEEE TNS., 65 (8) (2018) 2157

[10] A. Khan et al., IEEE TNS., 65 (8) (2018) 2152

**3 US and 1 EU patents, 1 is under review**



47.000 photons/MeV  
4.3% energy resolution



Scintillation material	Effective atomic number	Density (g/cm <sup>3</sup> )	Light yield (ph/MeV)	Major decay time (ns)
NaI(Tl)	50.8	3.67	38000	250
CsI(Tl)	54	4.51	52000	1000
BGO	75.2	7.13	9000	300
LYSO	65	7.1	33000	40
Cs <sub>2</sub> HfCl <sub>6</sub> <sup>(1)</sup>	58	3.86	54000	4100
<b>Tl<sub>2</sub>ZrCl<sub>6</sub><sup>(2)</sup></b>	<b>69</b>	<b>4.65</b>	<b>47000</b>	<b>2700</b>
<b>Tl<sub>2</sub>HfCl<sub>6</sub></b>	<b>71</b>	<b>5.25</b>	<b>32000</b>	<b>1000</b>
LaBr <sub>3</sub> (Ce)	44.1	5.08	89,000	16

# New semiconductor by Korea Univ.



**1. Furnace**



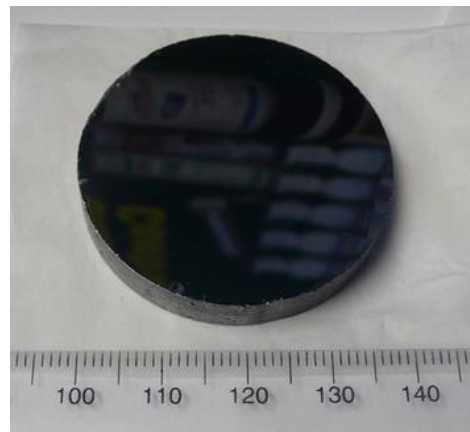
**2. Ingot**



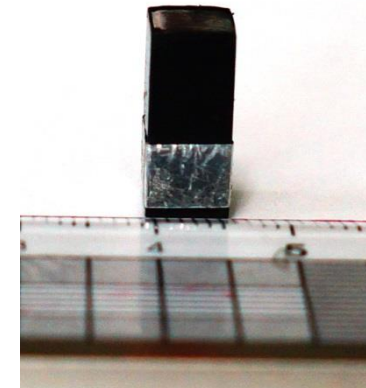
**3. Wire Sawing**



**4. Polishing**

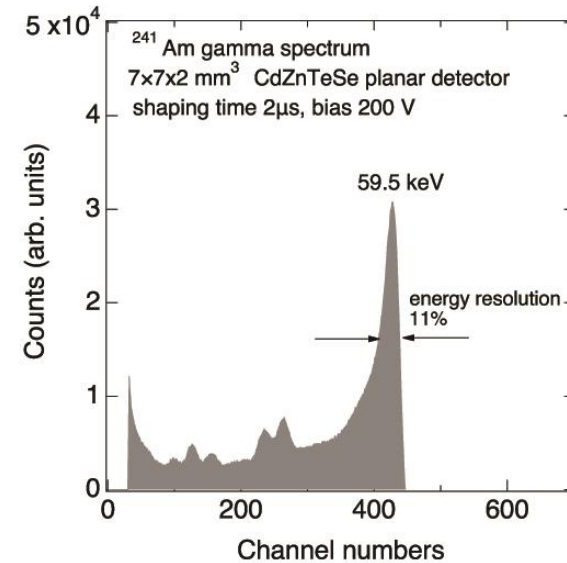
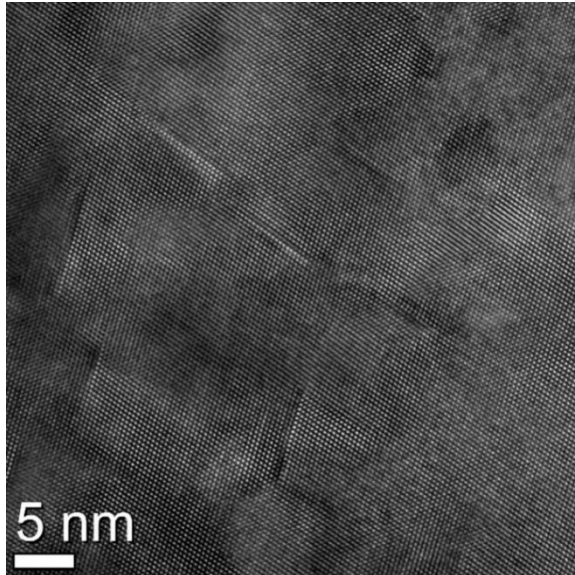


**5. Wafer**



**6. Detector (15mm)**

- . CZT 단결정 성장 -> Cd 증기압이 가장 높아 Cd 빈자리 생성
- . Cd 빈자리 보상을 위해 In, Al, Cl 불순물을 도핑
  - > 불순물은 전기적 특성을 저해하고, 구조적인 결함을 생성
  - > Cd 빈자리 결함농도를 낮출 수 있다면 불순물의 양도 감소됨.
- . Se의 녹는점은 Cd 보다 낮아, Se를 첨가하면 Cd 빈자리가 감소.
- . CdZnTeSe 단결정 성장에 대한 예비 실험 시 -> 긍정적 결과



**CdZnTeSe 단결정 결함 TEM사진**

**Am-241 감마 스펙트럼**

- . CdZnTe에 비해 dislocation 결함이 대략 10-15배 작음을 확인.
- . 전기적 특성에 결정적인 Te inclusion 분포 및 크기가 위치에 따라 다름->연구대상
- . CdSe 재료의 순도를 높여, CdZnTeSe 단결정을 성장할 경우,
- . 추가 연구를 통해 CdZnTe의 몇몇 단점을 극복할 수 있을 것으로 판단됨.

## 초고분해능 방사선 검출기 예시

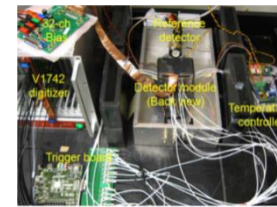
- 세계 최소형 핵의학(PET) 0.4 mm pixel array 검출기 개발
- 24x24 어레이 알고리즘으로 구별
- IEEE TNS, IEEE TRPMS 등 게재



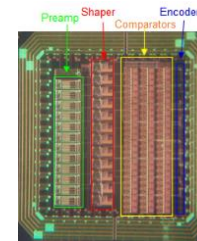
세계 최고분해능 핵의학 검출기 개발

## 방사선 검출기 회로 및 데이터획득장치 개발

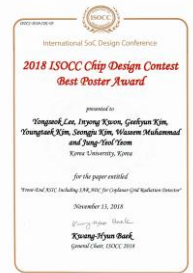
- 각종 방사선 검출기용 회로(ASIC주문형직접회로 포함) 및 데이터 획득 장치 (DAQ) 개발 등
- IEEE TNS, NIMA 등 논문 게재, 2018 ISOCC 국제학회 Best poster award 수상



DAQ



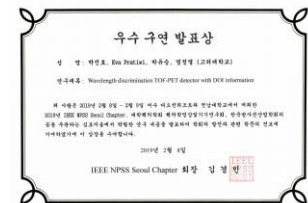
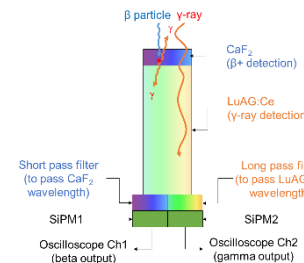
ASIC 회로



2018 ISOCC best poster award

## 새로운 방사선 검출기 개발

- 고성능 time-of-flight PET 검출기 개발
- 극한 환경(원전중대사고)용 방사선 검출기 개발 등
- NIMA, Phys. Med. Biol., Med. Phys. 등 다수 게재



2019 IEEE NPSS Seoul Chapter 공동심포지엄 우수구연발표상

## 섬광결정 성장

- uPD 및 브리지먼 기법 이용한 섬광결정 성장
- 섬광체 가공, 후처리 및 표면 처리



μPD장비



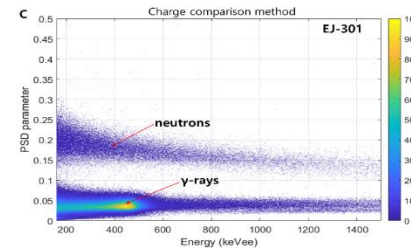
Bridgman장비



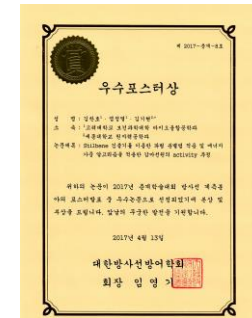
섬광결정

## 각종 신호 처리 알고리즘 개발

- Pulse shape discriminator (PSD, 파형구별법)을 이용한 감마-중성자 구별
- 고분해능 핵의학 검출기 depth-of-interaction (반응깊이) 구별 알고리즘 등



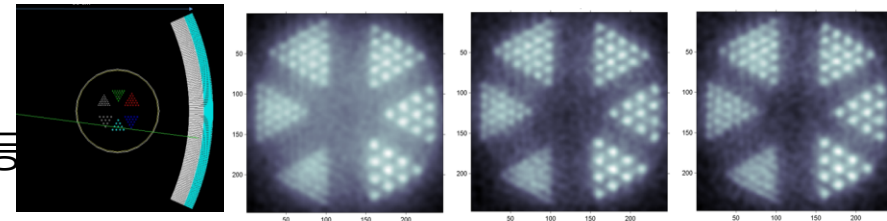
중성자, 감마 구별 결과



2017 방사선방어학회  
우수논문

## 시뮬레이션 및 영상재구성

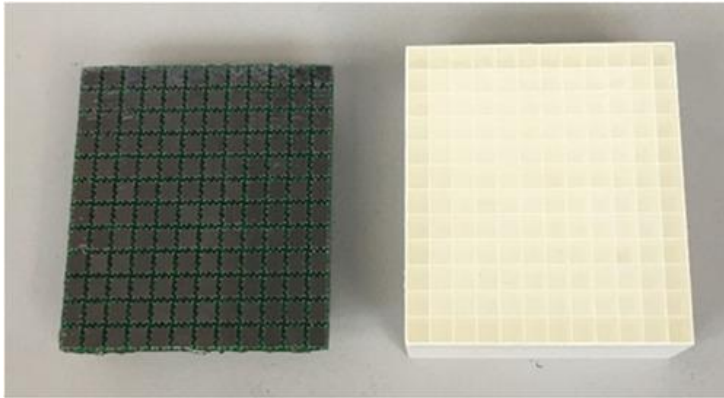
- GATE를 이용한 Gamma CT용 collimator 설계
- 핵의학영상기기 time-of-flight (TOF) 영상재구성 등



감마 CT용 collimator 시뮬레이션 결과 (a) (b) (c)



# Radiation Imager by JeJu Univ.



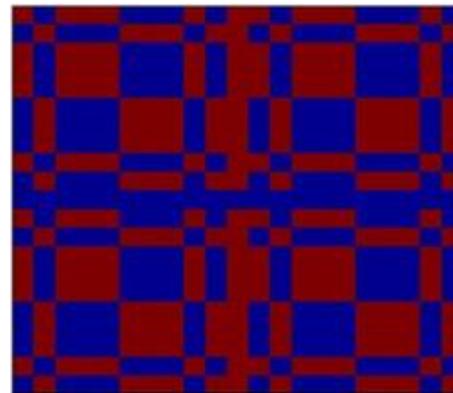
$12 \times 12$  SiPM pixel array and  $4 \times 4 \times 20$  mm<sup>3</sup> pixelated CsI(Tl)



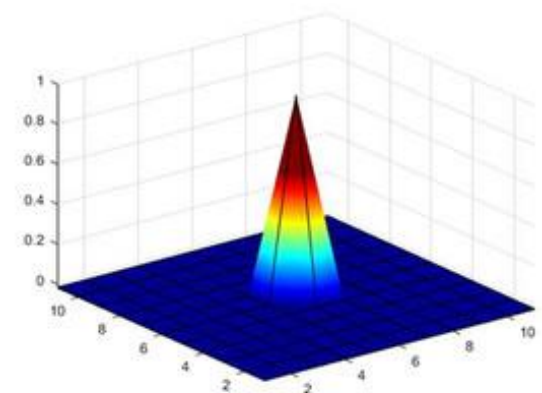
Detector system including DAQ board



MURA mask fabricated with a 3D printer and 20 mm thick tungsten pieces



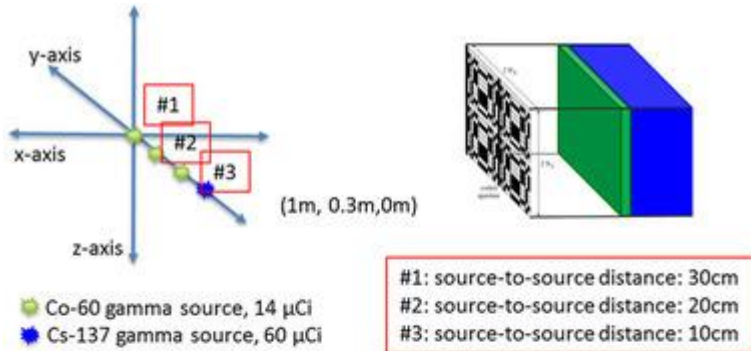
(a)



(b)

$21 \times 21$  MURA mask pattern (a) and its auto-correlated function plot with decoding pattern as delta function

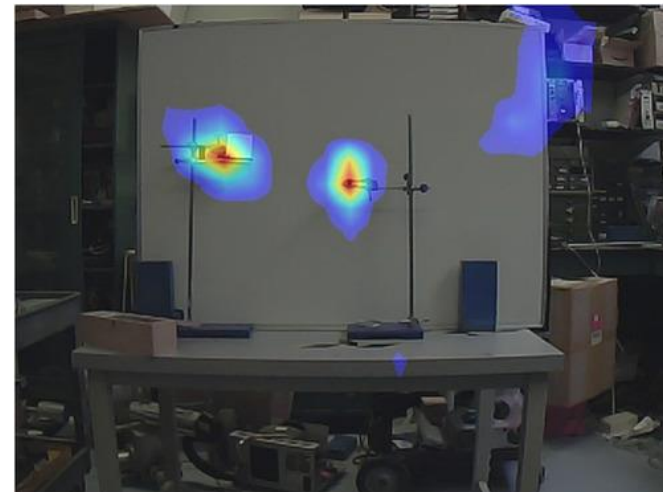
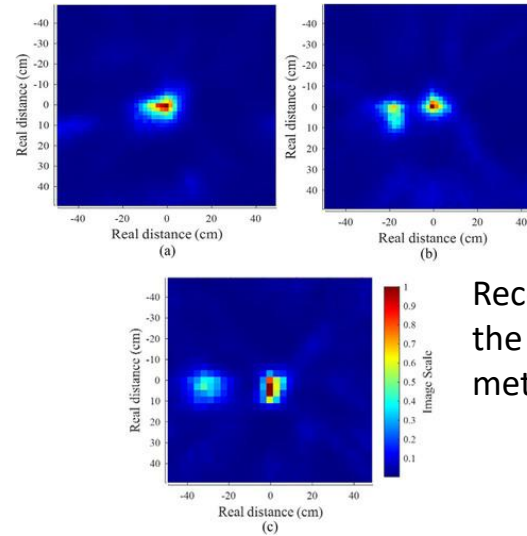
# Radiation Imager by JeJu Univ.



(a)

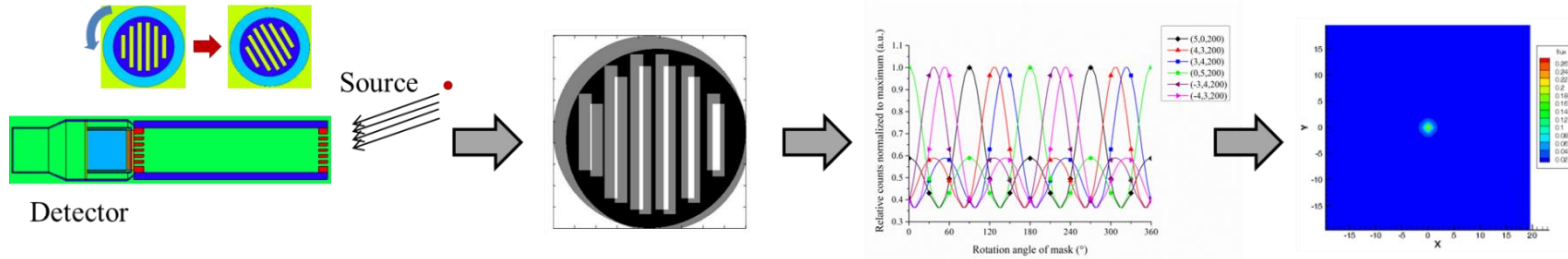


(b)

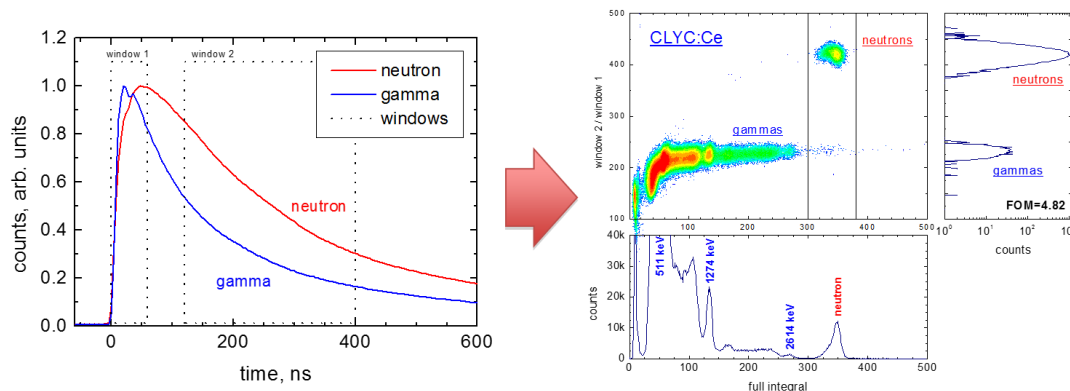


## ■ Rotational Modulation Collimator (RMC)

- Originally developed for X-ray and solar flare imaging in astronomy.
- Does not require a position-sensitive radiation detector.
- As collimators rotate, the open area made by slits change over time.



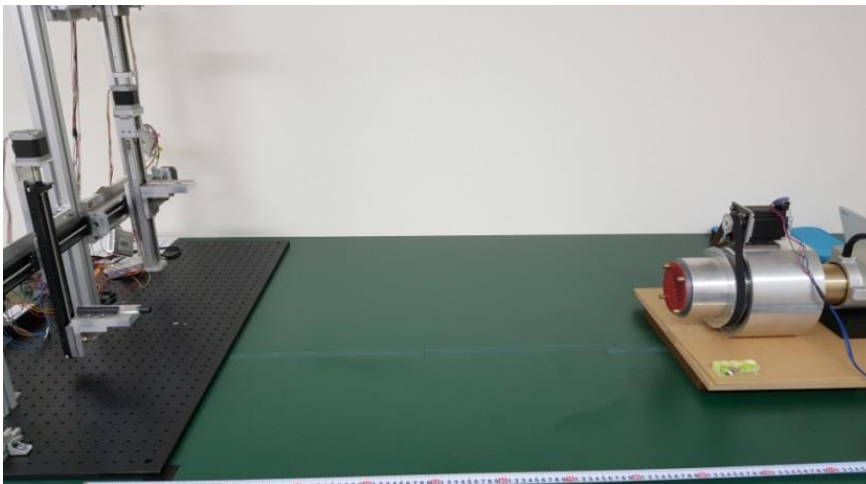
## ■ PSD-capable Scintillators



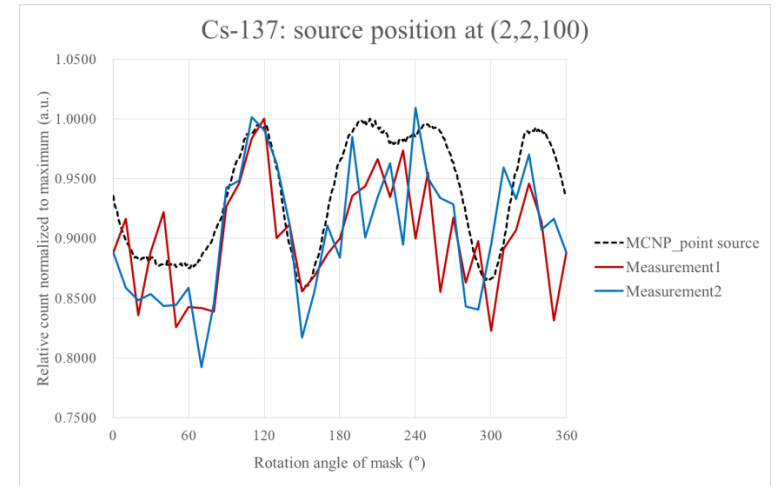
## 감마선원 계측 및 영상화 실험

- 감마선원을 이용한 RMC 영상화 실험
  - 비대칭 집속기 사용 (Pb 1 cm+ BPE 0.2 cm)
  - RMC와 방사선원 사이 거리: 1 m
  - 측정 선원:  $^{137}\text{Cs}$  10.23  $\mu\text{Ci}$ ,  $^{133}\text{Ba}$  10.64  $\mu\text{Ci}$  (reference date 2016-04-01)

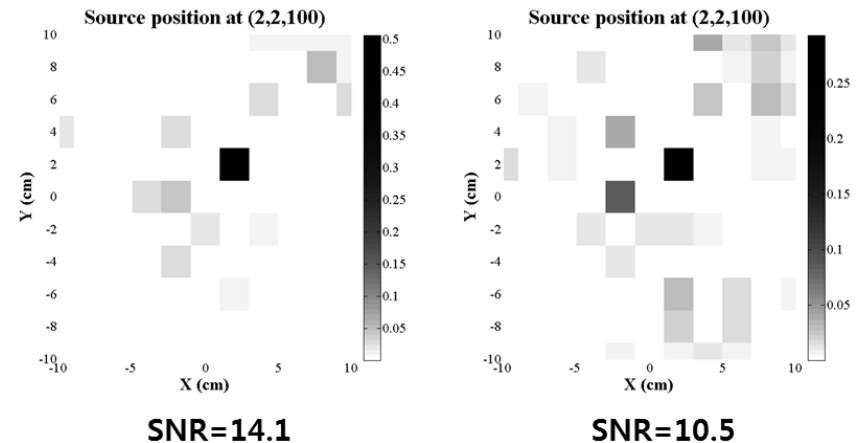
<감마선원 계측 및 영상화 실험>



<Cs-137 선원에 대한 회전 변조 패턴>



<재구성된 방사선원 분포 영상>



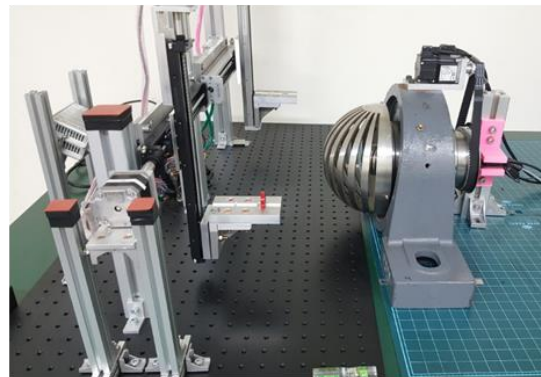
MLEM iteration 5,000회

Courtesy by Prof. Kihyun Kim

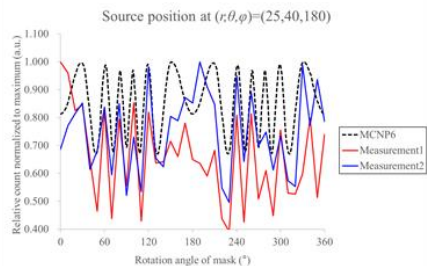
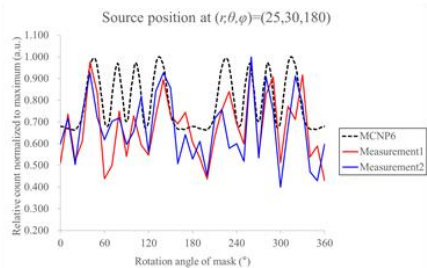
## 선원 세기/타입 변화에 따른 변조패턴

- **감마선원을 이용한 RMC 영상화 실험**
  - 선원위치:  $(r, \theta, \varphi) = (25 \text{ cm}, 30^\circ, 180^\circ)$ ,  
 $(25 \text{ cm}, 40^\circ, 180^\circ)$
  - 측정 선원:  $^{133}\text{Ba}$  89.52  $\mu\text{Ci}$  (D-type source, reference date 2018-08-01)
  - Dwell time: 10 min

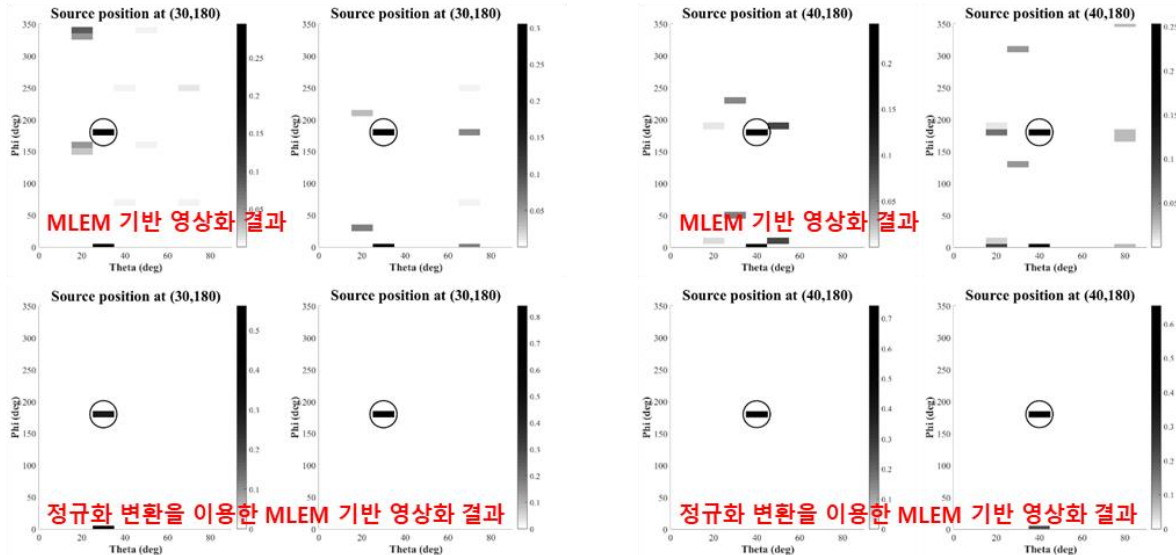
<감마선원 계측 및 영상화 실험>

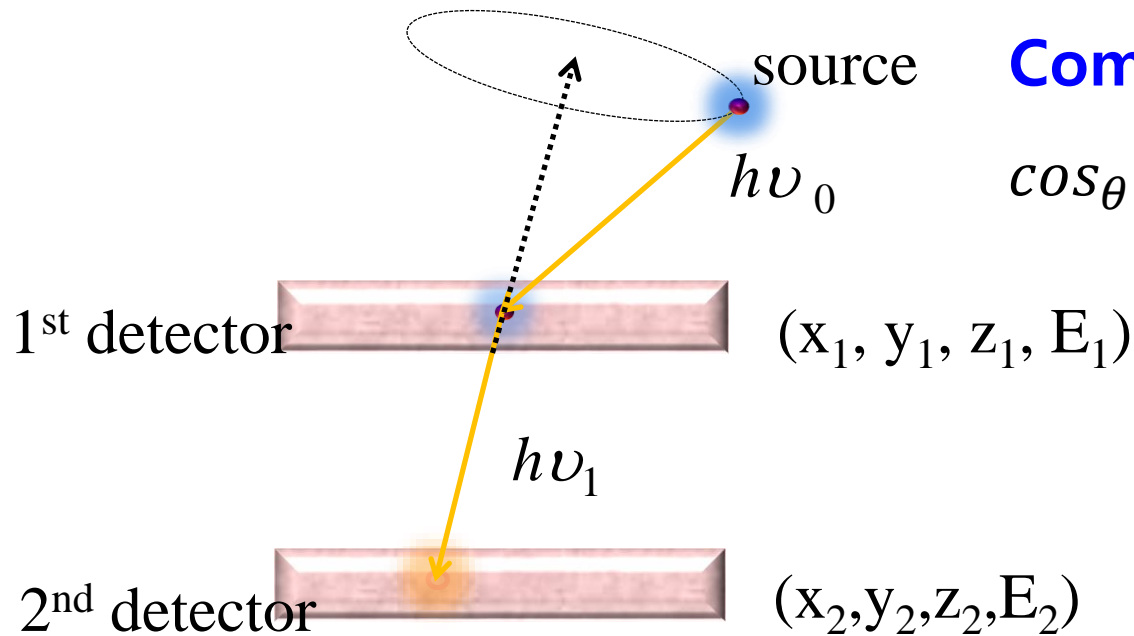


<Ba-133 선원에 대한 회전 변조 패턴>



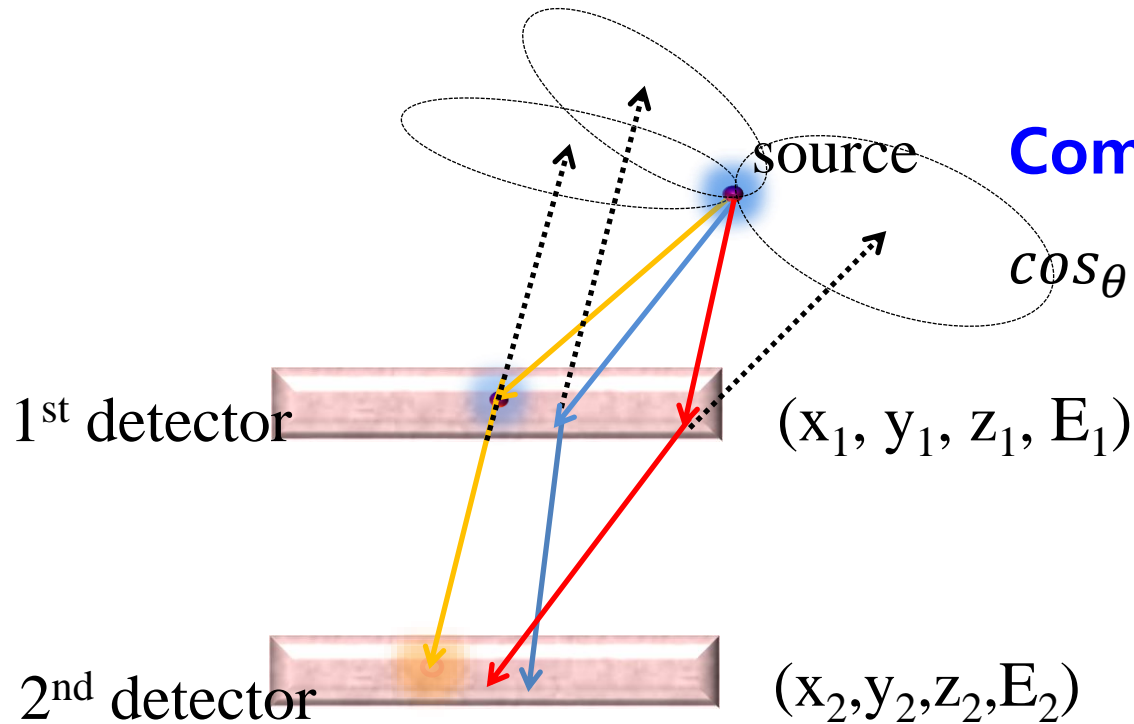
<재구성된 방사선원 분포 영상>





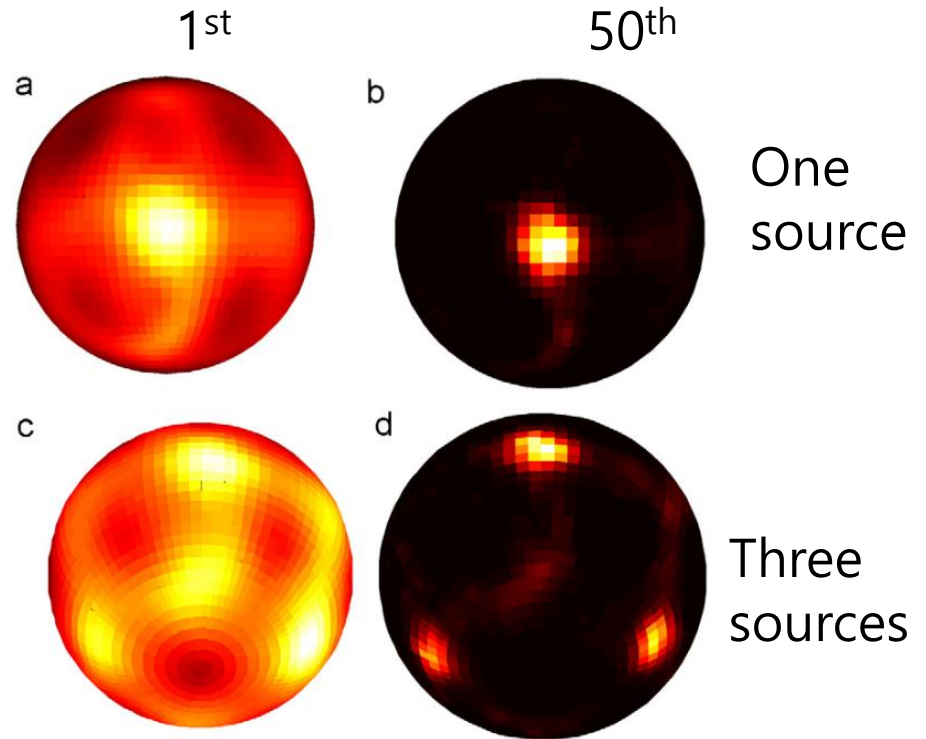
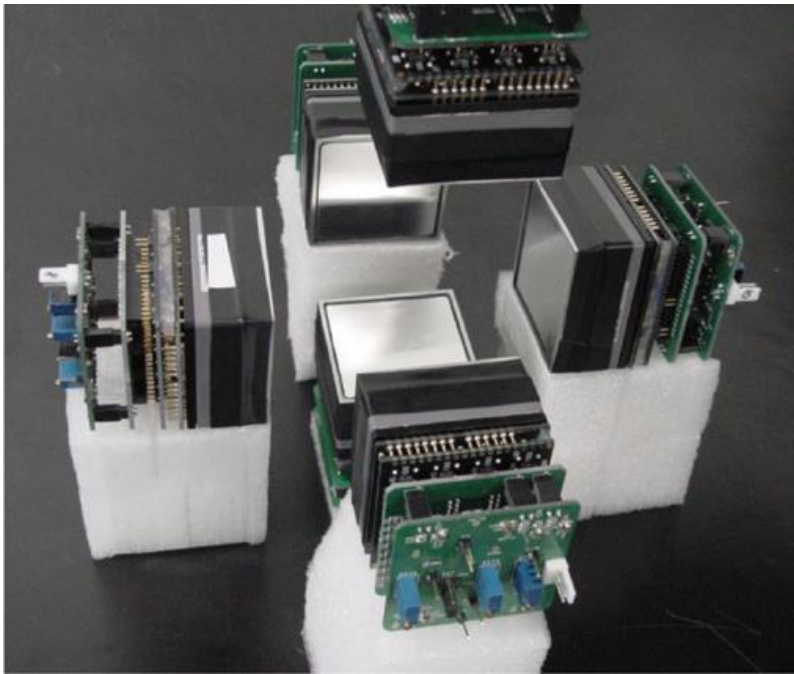
## Compton Reconstruction

$$\cos\theta = 1 - \left( \frac{m_0 c^2}{h\nu_0} \cdot \frac{E_1}{(h\nu_0 - E_1)} \right)$$



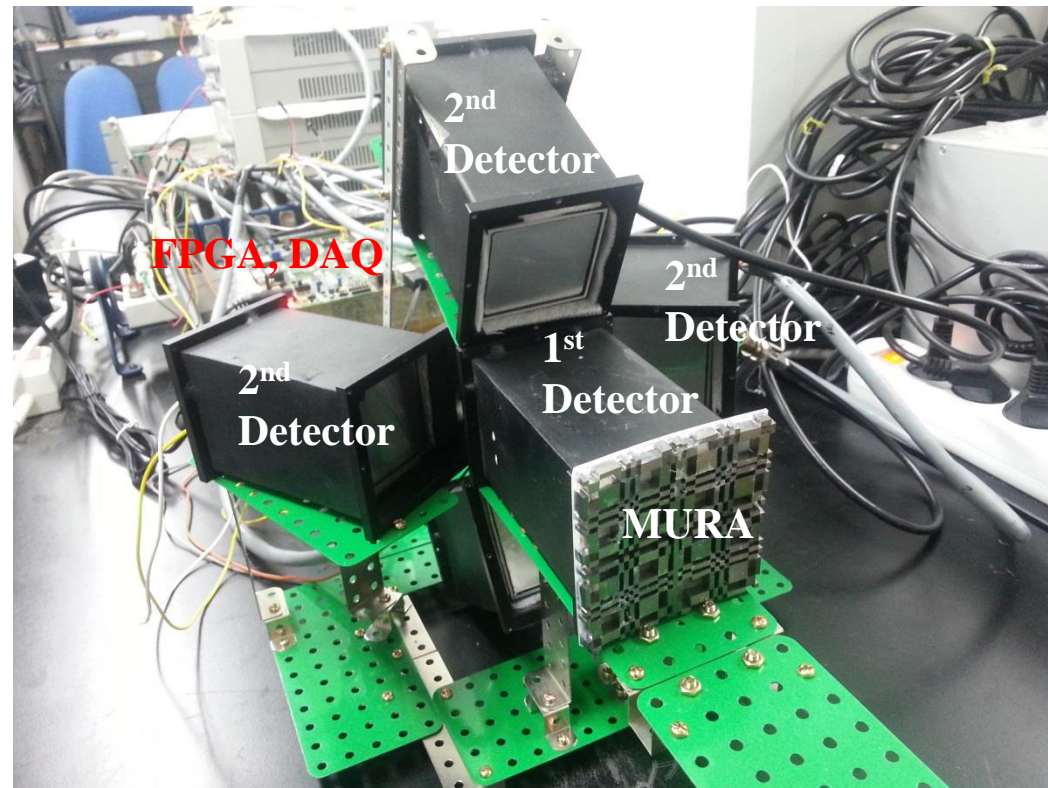
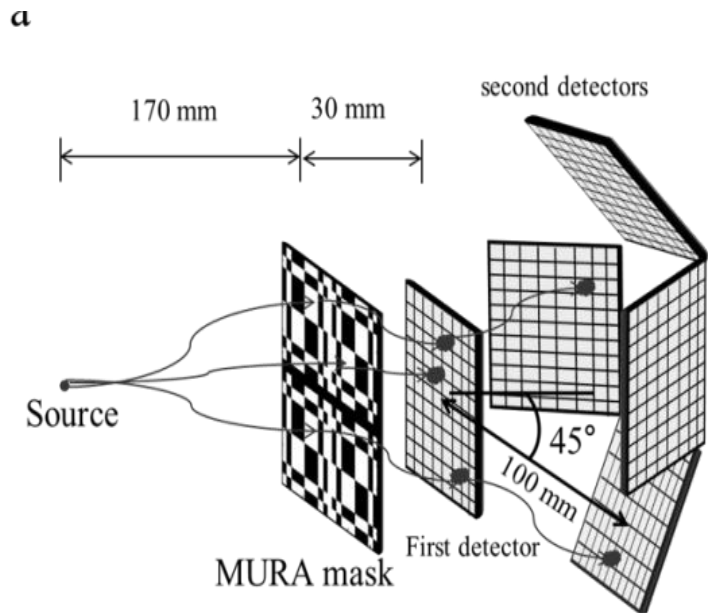
## Compton Reconstruction

$$\cos\theta = 1 - \left( \frac{m_0 c^2}{h\nu_0} \cdot \frac{E_1}{(h\nu_0 - E_1)} \right)$$

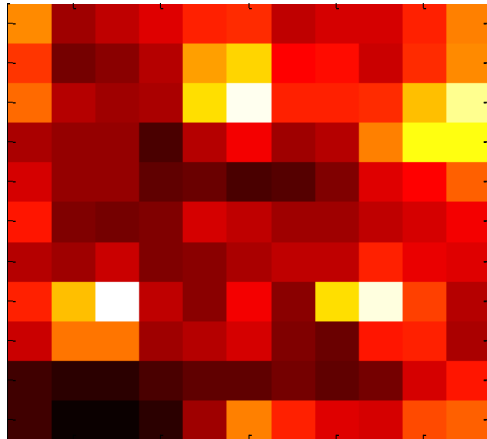


Intrinsic Efficiency :  $4.67 \times 10^{-4}$

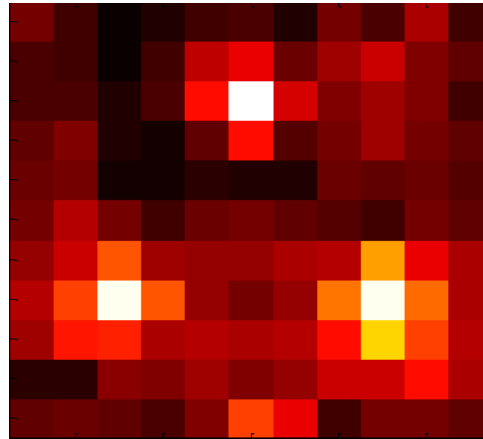




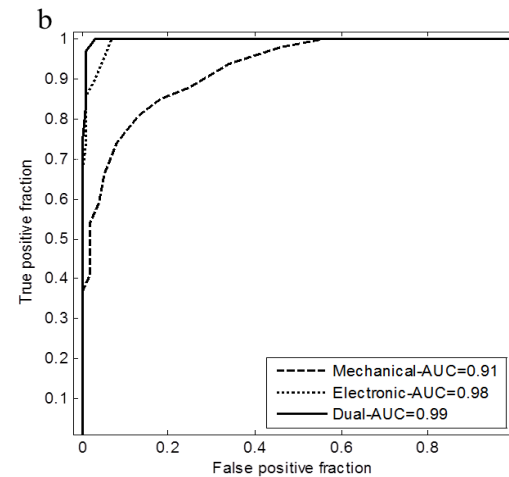
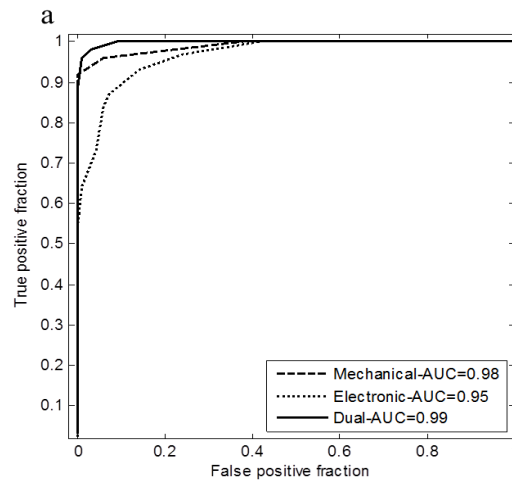
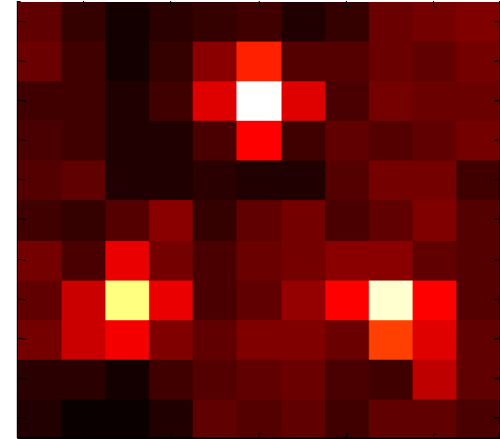
## Coded aperture



## Compton

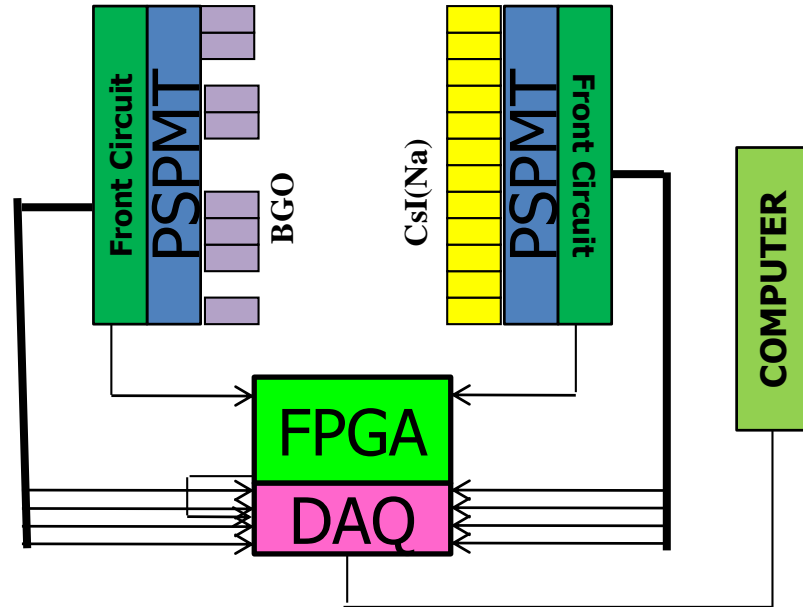
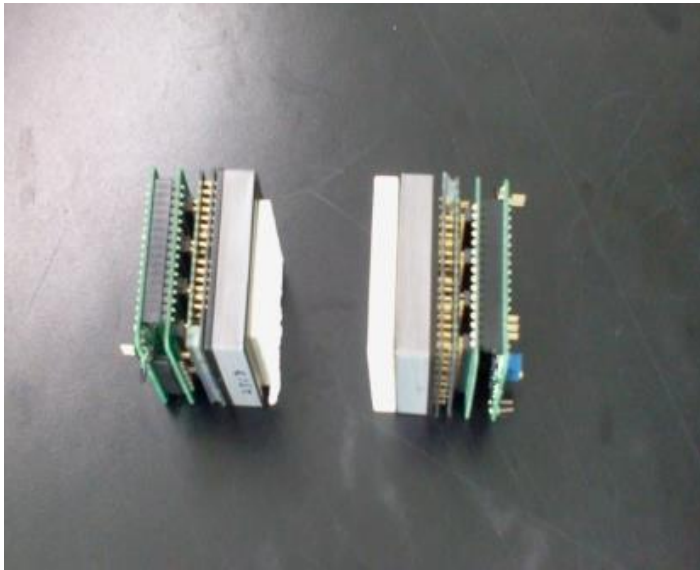


## Dual



662 keV

## Coded mask made by a scintillator array (BGO)



URA (SICCAS)



Planar (Hilgers)



(Hamamatsu)



(Custom-made)

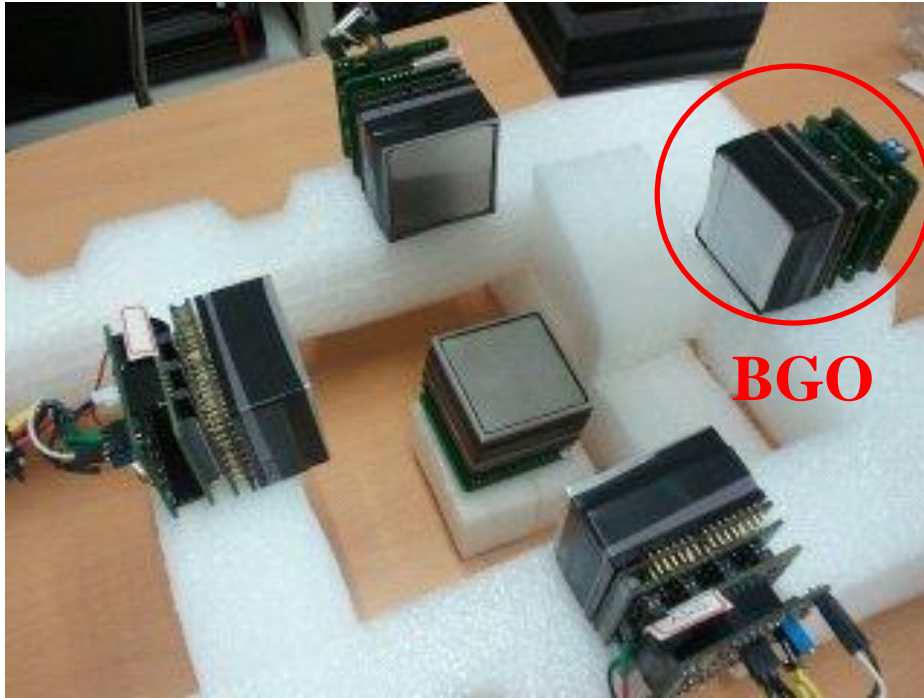


(Digilent)



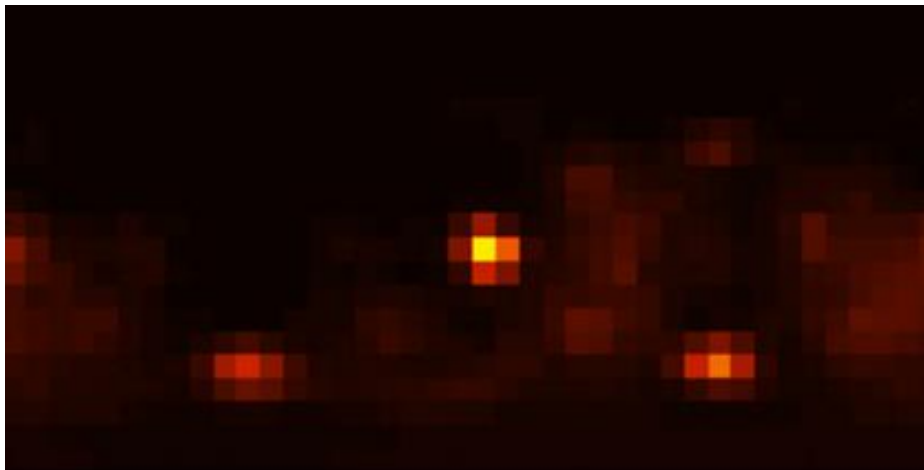
(NI)

# Radiation Imager by Korea Univ.



Taewoong Lee, Wonho Lee\*,  
2014, IEEE TNS, **61**, No.1, 654-662

Taewoong Lee and Wonho Lee\*  
2014, ARI, **90**, 102-108



Three 662 keV sources

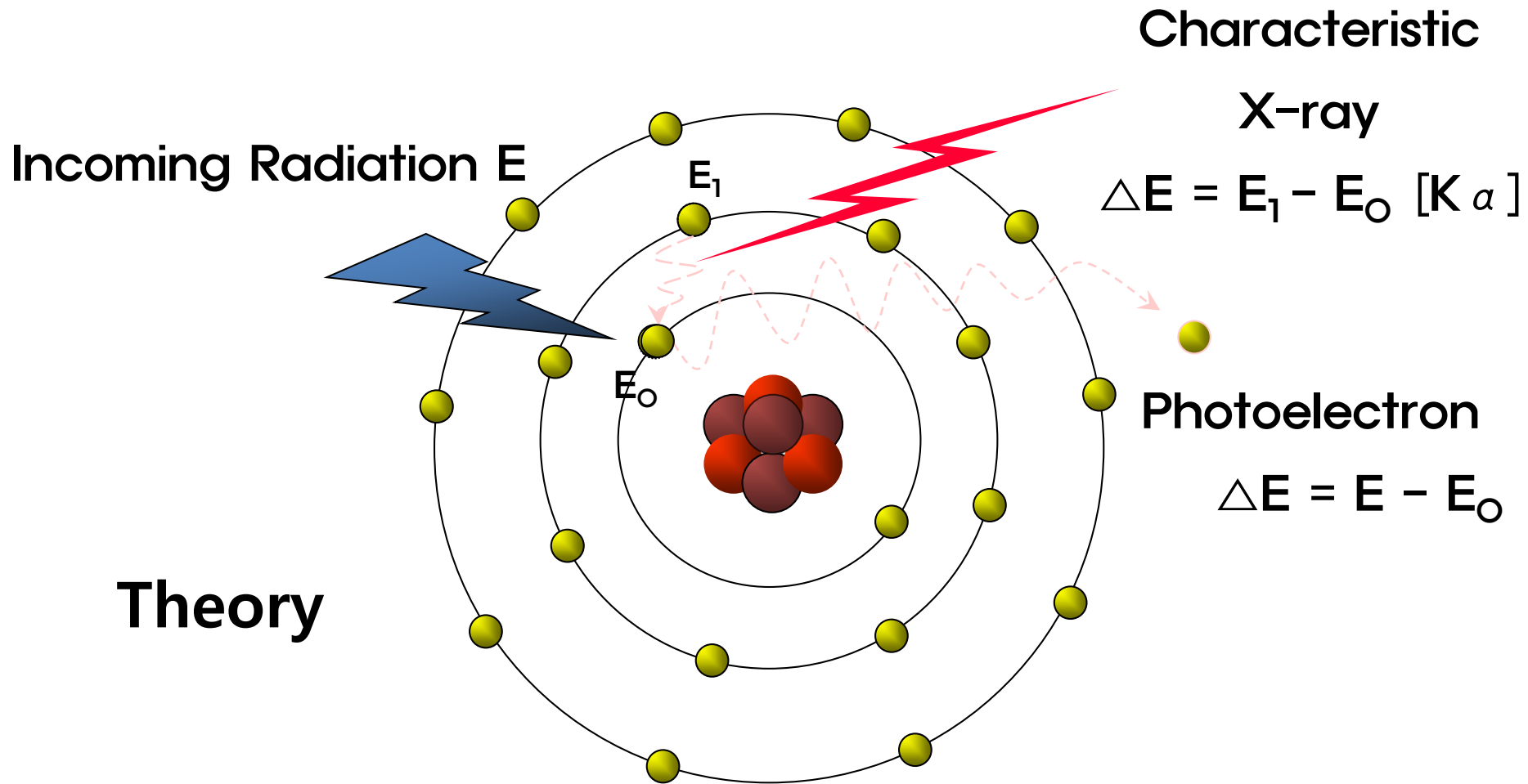


**KOREA**  
UNIVERSITY

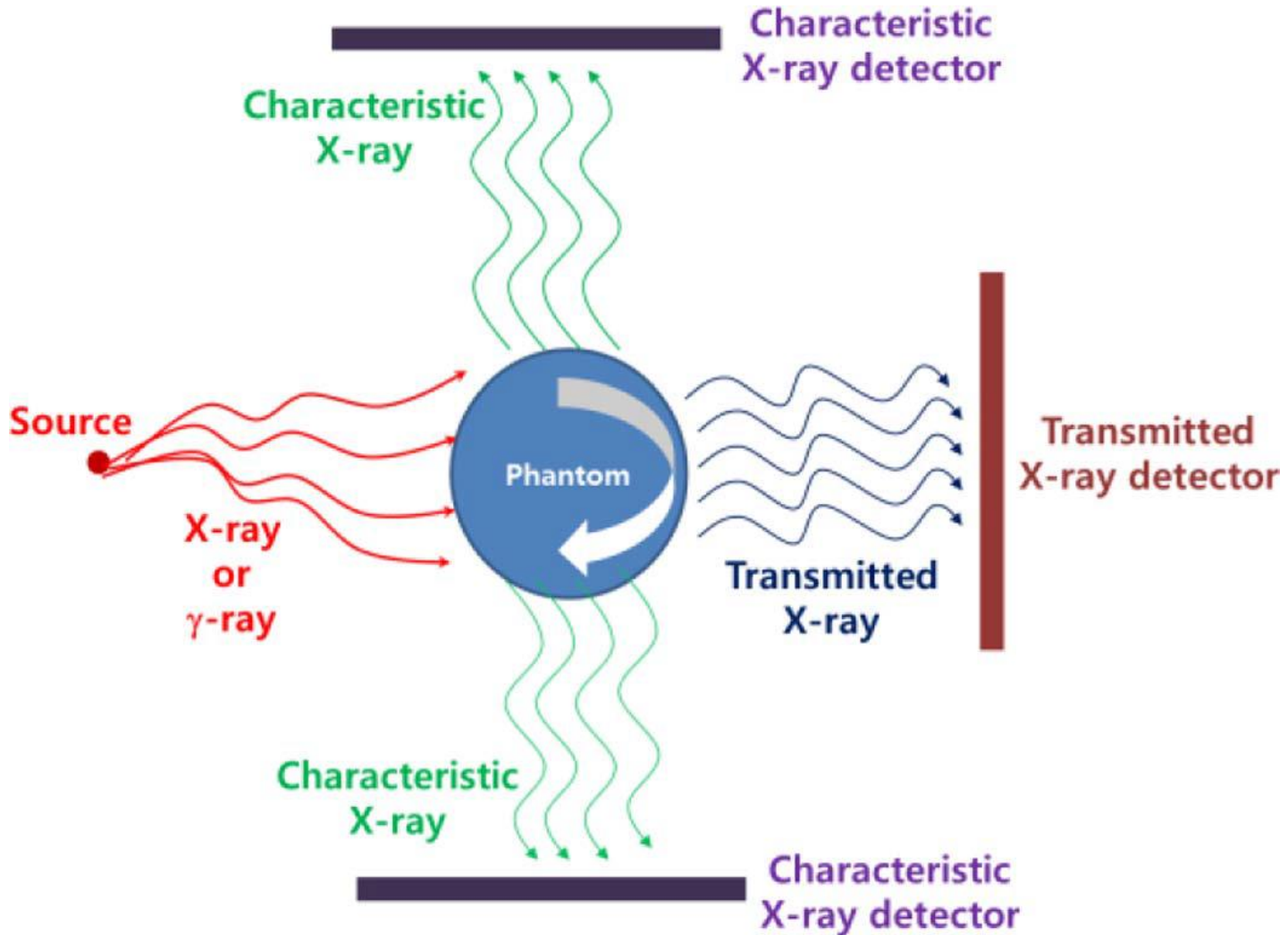
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# Current Researches of RMI Lab in Korea Univ.

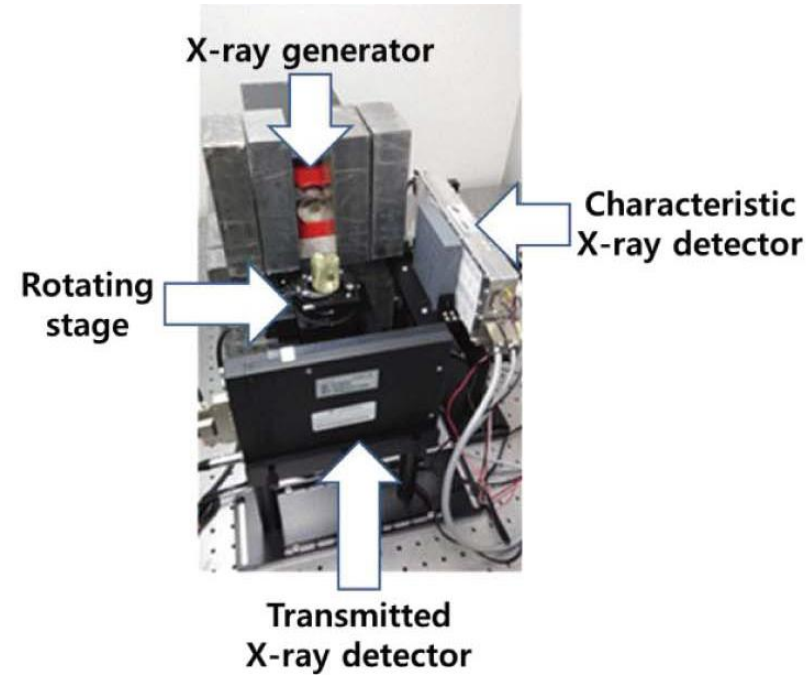
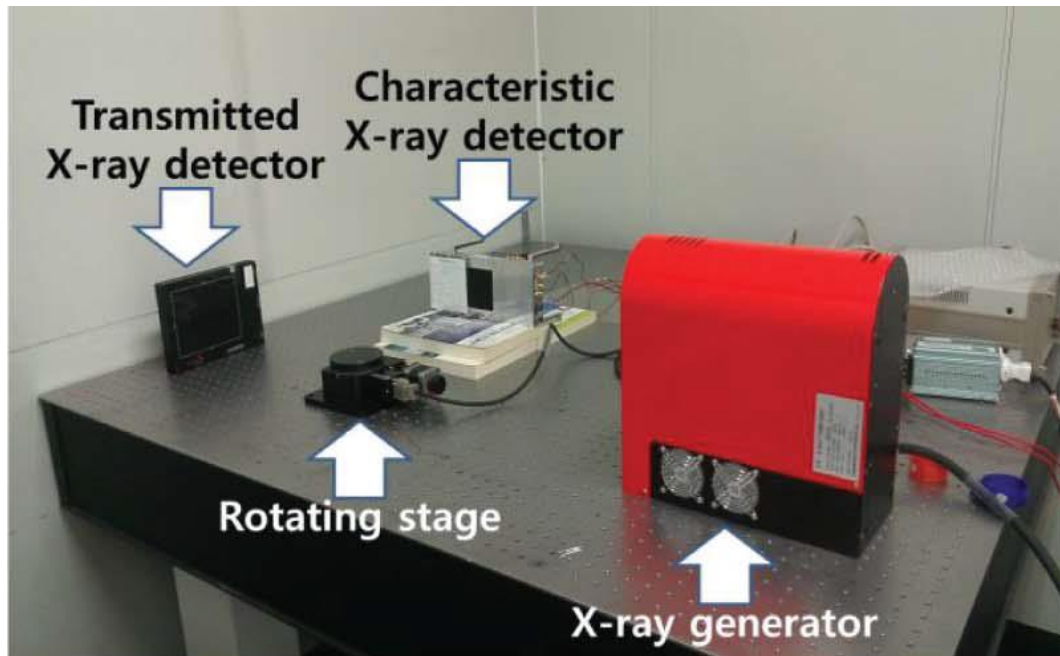
---



# FXCT: Schematic Diagram

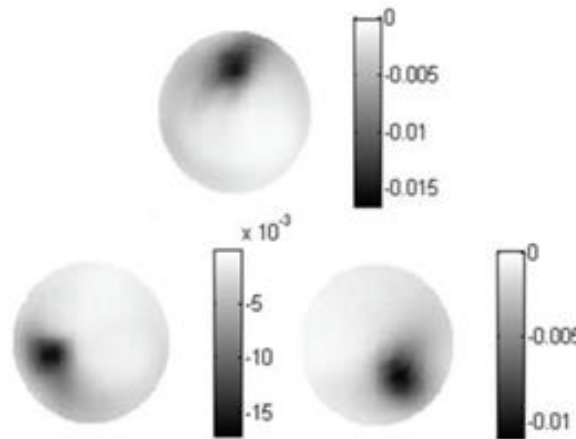
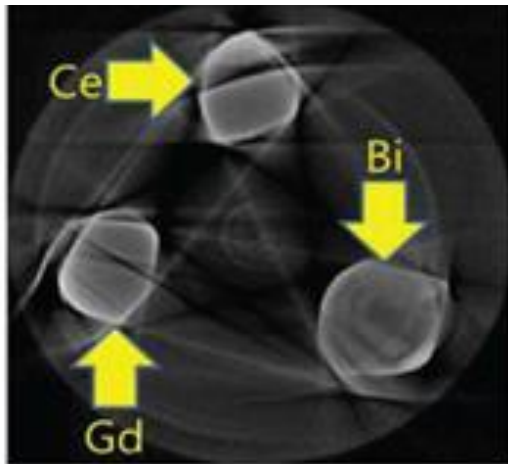
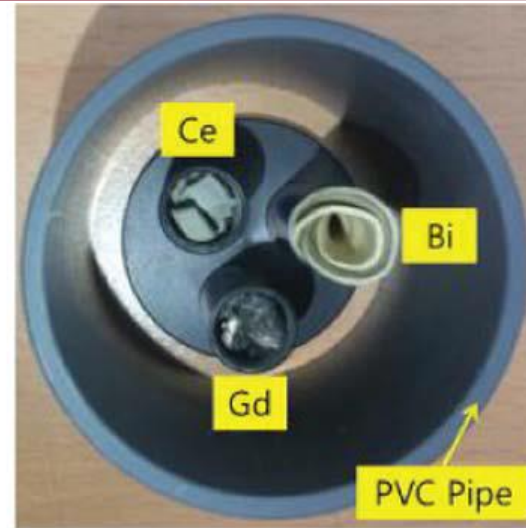
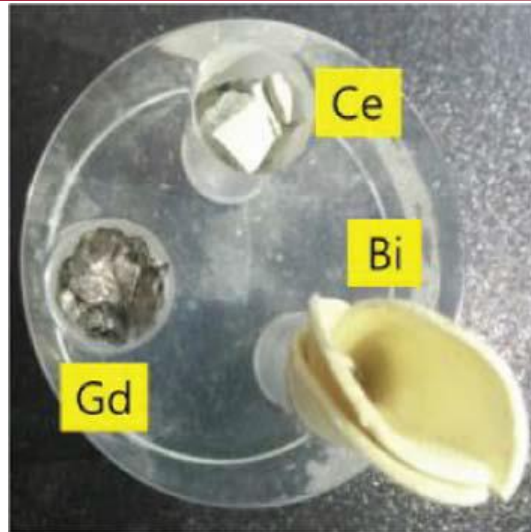


# FXCT System Photos





# FXCT Experiment (1<sup>st</sup> generation)

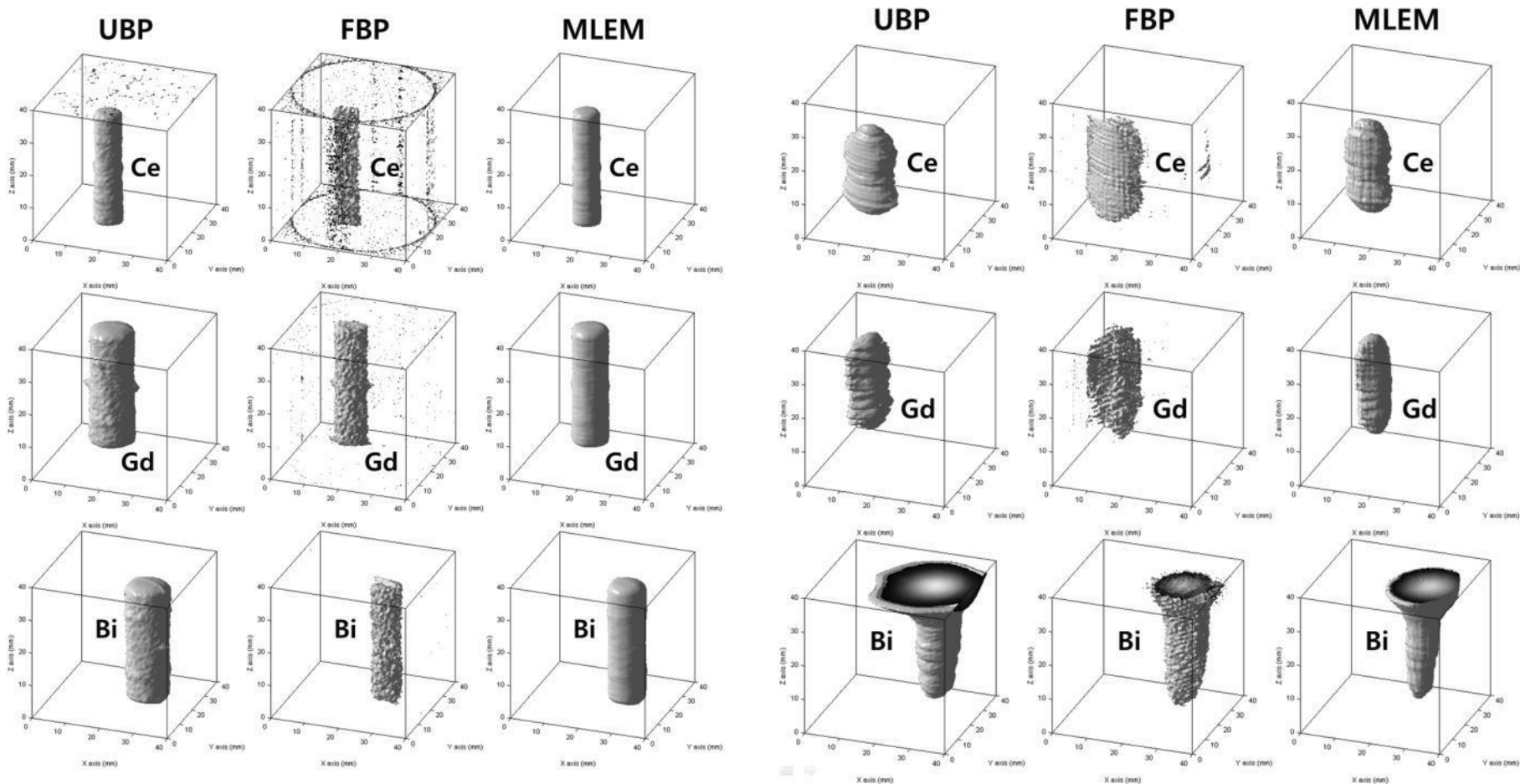


Transmission image

Characteristic image

Combined image

## 3D Rendered Images



Simulation

Experiment

## Detectable Depth

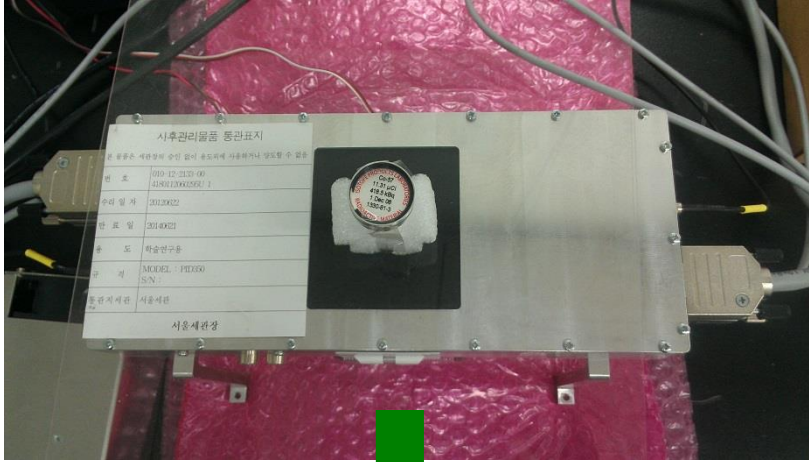
Pipe material	thickness [mm]			
	0.7	1.5	2.25	3
PVC	O	O	O	O
Al	O	O	O	O
Stainless Steel	O	O	X	X
Cu	O	X	X	X



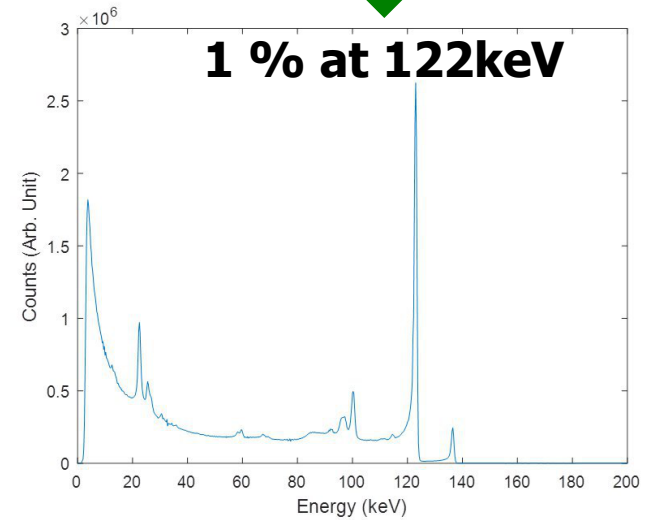
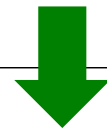
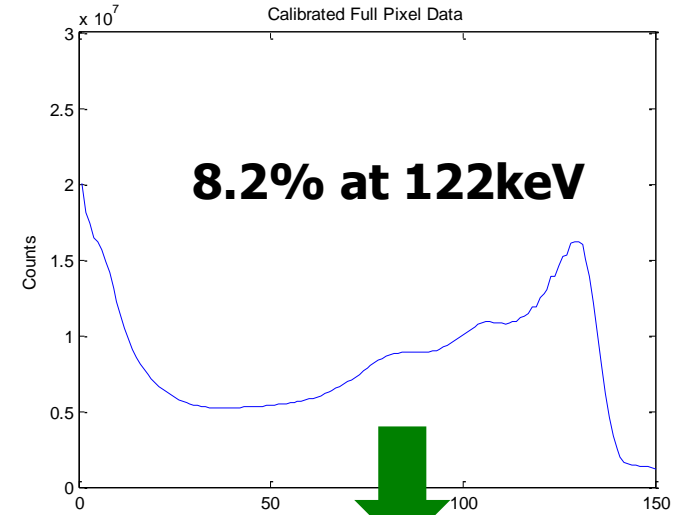
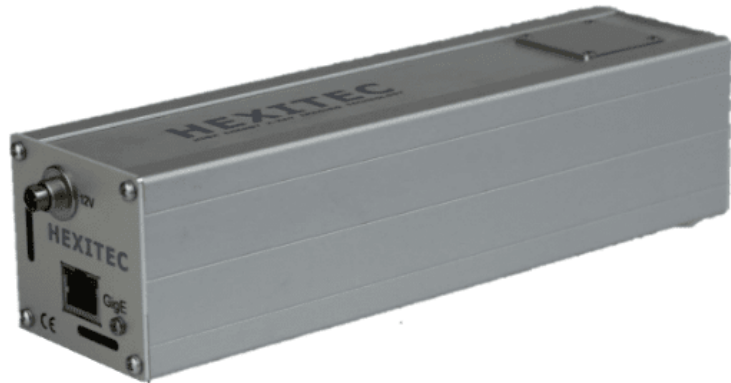
**KOREA UNIVERSITY**

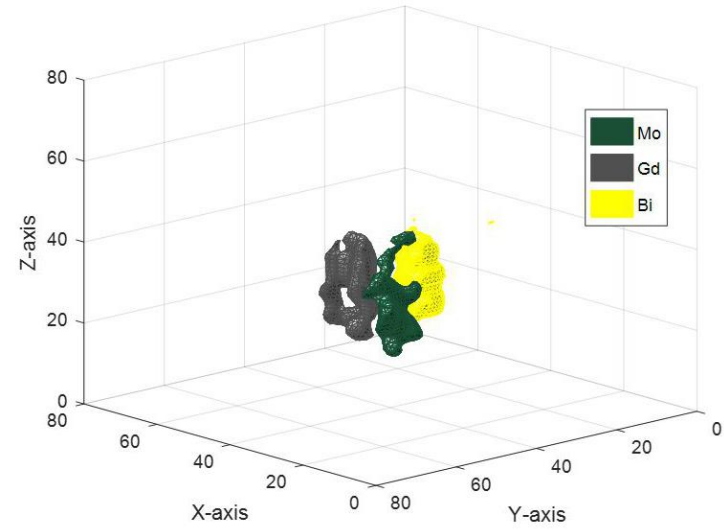
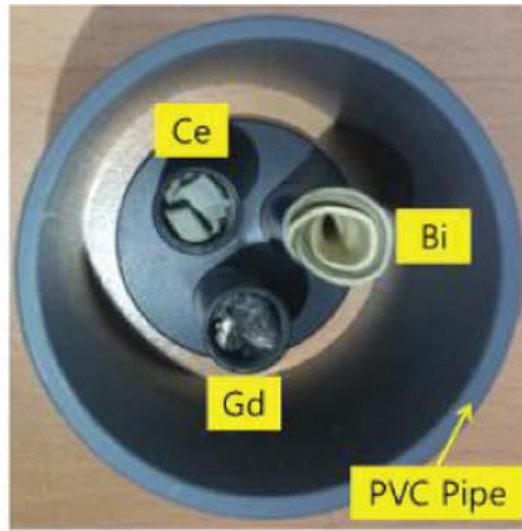
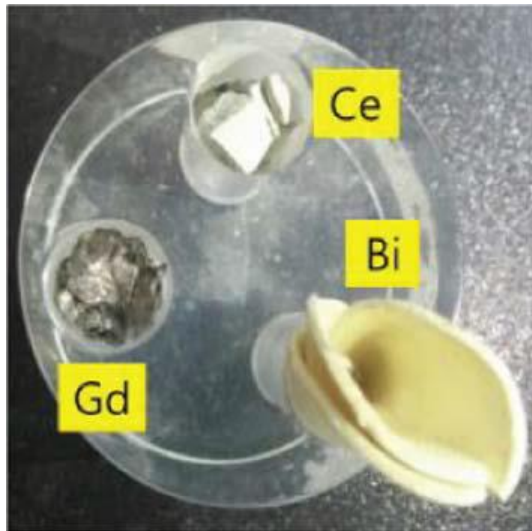
# FXCT Experiment (1<sup>st</sup> -> 2<sup>nd</sup> Generation)

1<sup>st</sup>  
Detector  
AJAT

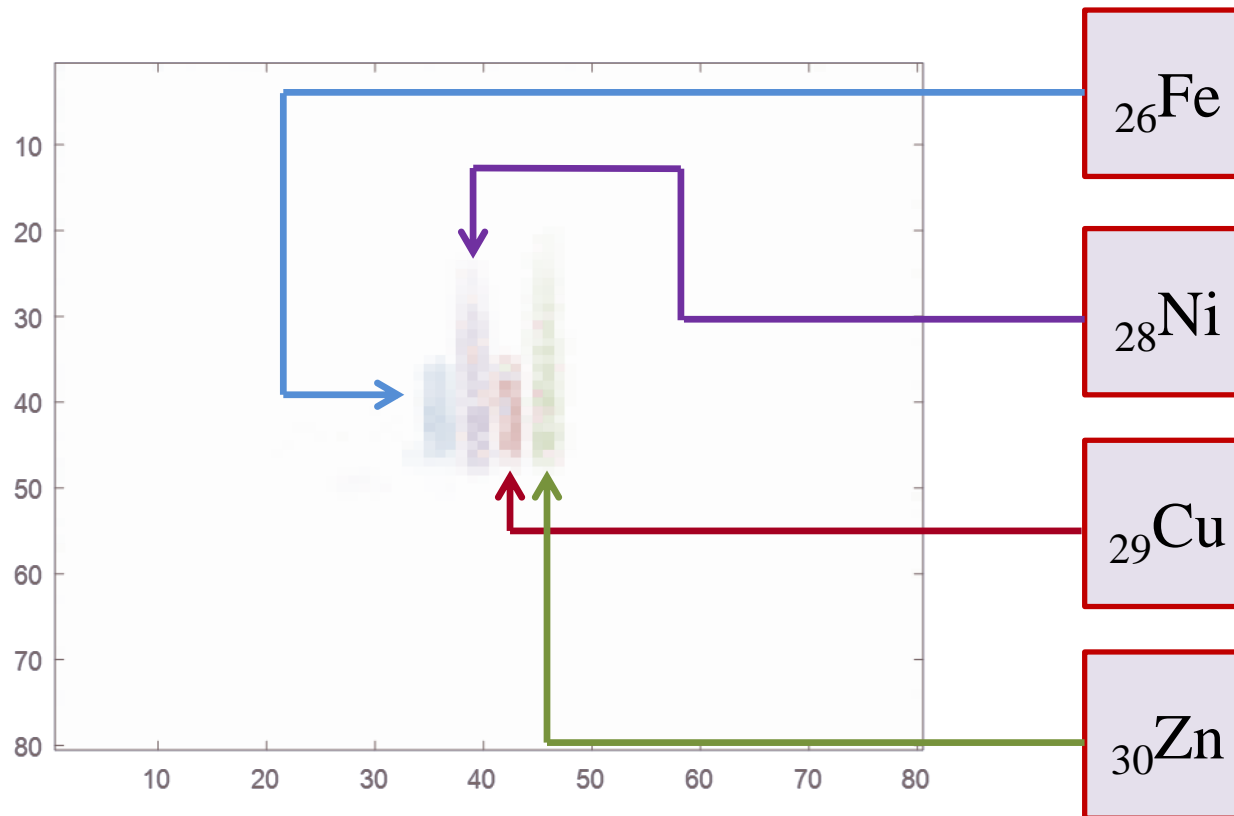


2<sup>nd</sup>  
Detector  
HEXITEC





Even if  $\Delta Z=1$ , they are discriminated from each other!



## Detected and Analyzed Materials

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18
1	<sup>1</sup> H																	<sup>2</sup> He
2	<sup>3</sup> Li	<sup>4</sup> Be											<sup>5</sup> B	<sup>6</sup> C	<sup>7</sup> N	<sup>8</sup> O	<sup>9</sup> F	<sup>10</sup> Ne
3	<sup>11</sup> Na	<sup>12</sup> Mg											<sup>13</sup> Al	<sup>14</sup> Si	<sup>15</sup> P	<sup>16</sup> S	<sup>17</sup> Cl	<sup>18</sup> Ar
4	<sup>19</sup> K	<sup>20</sup> Ca	<sup>21</sup> Sc	<sup>22</sup> Ti	<sup>23</sup> V	<sup>24</sup> Cr	<sup>25</sup> Mn	<sup>26</sup> Fe	<sup>27</sup> Co	<sup>28</sup> Ni	<sup>29</sup> Cu	<sup>30</sup> Zn	<sup>31</sup> Ga	<sup>32</sup> Ge	<sup>33</sup> As	<sup>34</sup> Se	<sup>35</sup> Br	<sup>36</sup> Kr
5	<sup>37</sup> Rb	<sup>38</sup> Sr	<sup>39</sup> Y	<sup>40</sup> Zr	<sup>41</sup> Nb	<sup>42</sup> Mo	<sup>43</sup> Tc	<sup>44</sup> Ru	<sup>45</sup> Rh	<sup>46</sup> Pd	<sup>47</sup> Ag	<sup>48</sup> Cd	<sup>49</sup> In	<sup>50</sup> Sn	<sup>51</sup> Sb	<sup>52</sup> Te	<sup>53</sup> I	<sup>54</sup> Xe
6	<sup>55</sup> Cs	<sup>56</sup> Ba	<sup>57</sup> La	<sup>72</sup> Hf	<sup>73</sup> Ta	<sup>74</sup> W	<sup>75</sup> Re	<sup>76</sup> Os	<sup>77</sup> Ir	<sup>78</sup> Pt	<sup>79</sup> Au	<sup>80</sup> Hg	<sup>81</sup> Tl	<sup>82</sup> Pb	<sup>83</sup> Bi	<sup>84</sup> Po	<sup>85</sup> At	<sup>86</sup> Rn
7	<sup>87</sup> Fr	<sup>88</sup> Ra	<sup>89</sup> Ac	<sup>104</sup> Rf	<sup>105</sup> Db	<sup>106</sup> Sg	<sup>107</sup> Bh	<sup>108</sup> Hs	<sup>109</sup> Mt	<sup>110</sup> Ds	<sup>111</sup> Rg	<sup>112</sup> Cp	<sup>113</sup> Uut	<sup>114</sup> Uuq	<sup>115</sup> Uup	<sup>116</sup> Uuh	<sup>117</sup> Uus	<sup>118</sup> Uuo
란탄족					<sup>58</sup> Ce	<sup>59</sup> Pr	<sup>60</sup> Nd	<sup>61</sup> Pm	<sup>62</sup> Sm	<sup>63</sup> Eu	<sup>64</sup> Gd	<sup>65</sup> Tb	<sup>66</sup> Dy	<sup>67</sup> Ho	<sup>68</sup> Er	<sup>69</sup> Tm	<sup>70</sup> Yb	<sup>71</sup> Lu
악티늄족					<sup>90</sup> Th	<sup>91</sup> Pa	<sup>92</sup> U	<sup>93</sup> Np	<sup>94</sup> Pu	<sup>95</sup> Am	<sup>96</sup> Cm	<sup>97</sup> Bk	<sup>98</sup> Cf	<sup>99</sup> Es	<sup>100</sup> Fm	<sup>101</sup> Md	<sup>102</sup> No	<sup>103</sup> Lr

연구실 보유	구매 진행중	화합물 형태 보유	추정 불가	미구매예정 (가격)	상업적 취급 X
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# FXCT Experiment (2<sup>nd</sup> Generation)

www.BANDICAM.com

## FXCT Image Reconstruction GUI Test

Calibration

Load Files

GUI Version  
New Version

Spectrum Type  
Raw data

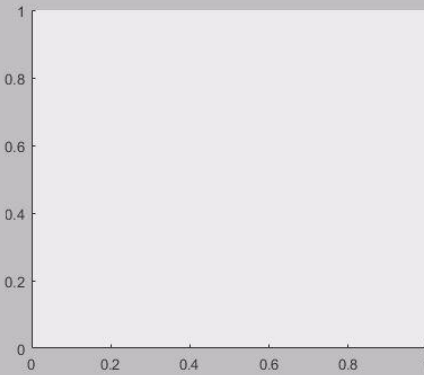
Load Files(CT)

Recon CT image

Select layer #(1-80)  
40

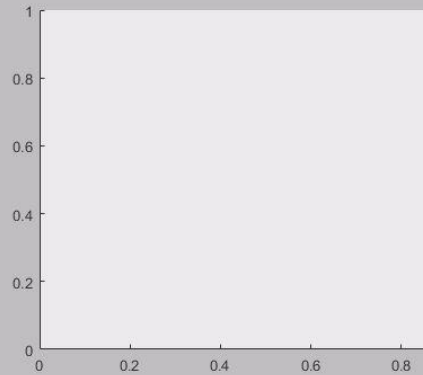
Select filter  
none

Show Spectrum



Energy Spectrum

Get Spectrum



Min E : 0 keV    Max E : 200 keV

Show Image

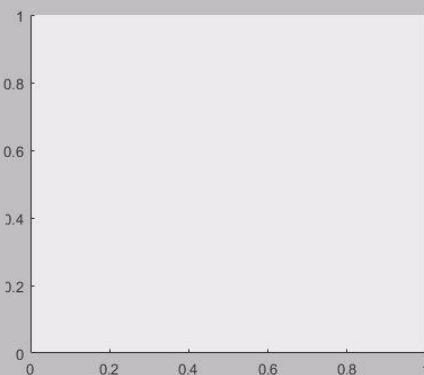
Get Image

Zoom

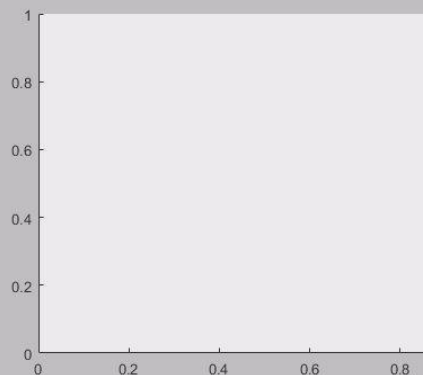
Pixel Inform...

### Material List

- Hydrogen(H)
- Helium(He)
- Lithium(Li)
- Beryllium(Be)
- Boron(B)
- Carbon(C)
- Nitrogen(N)
- Oxygen(O)
- Fluorine(F)
- Neon(Ne)
- Sodium(Na)
- Magnesium(Mg)
- Aluminium(Al)
- Silicon(Si)
- Phosphorus(P)
- Sulfur(S)
- Chlorine(Cl)
- Argon(Ar)
- Potassium(K)
- Calcium(Ca)
- Scandium(Sc)
- Titanium(Ti)
- Vanadium(V)
- Chromium(Cr)
- Manganese(Mn)
- Iron(Fe)
- Cobalt(Co)
- Nickel(Ni)
- Copper(Cu)
- Zinc(Zn)
- Gallium(Ga)
- Germanium(Ge)
- Arsenic(As)
- Selenium(Se)
- Bromine(Br)
- Krypton(Kr)
- Rubidium(Rb)
- Strontium(Sr)
- Yttrium(Y)
- Zirconium(Zr)
- Niobium(Nb)
- Molybdenum(Mo)
- Technetium(Tc)
- Ruthenium(Ru)
- Rhodium(Rh)
- Palladium(Pd)
- Silver(Ag)
- Cadmium(Cd)
- Indium(In)
- Tin(Sn)
- Antimony(Sb)
- Tellurium(Te)
- Iodine(I)

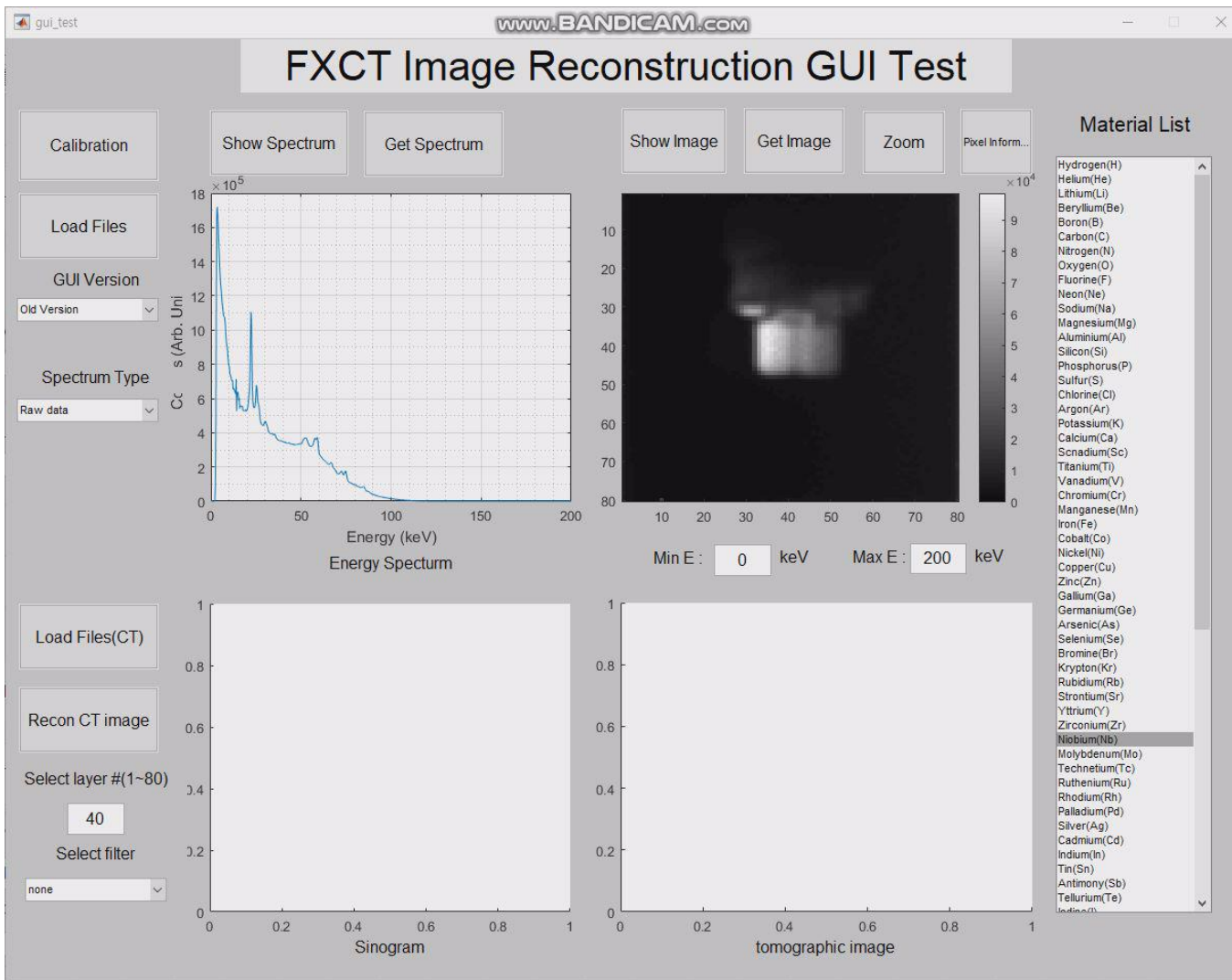


Sinogram



tomographic image



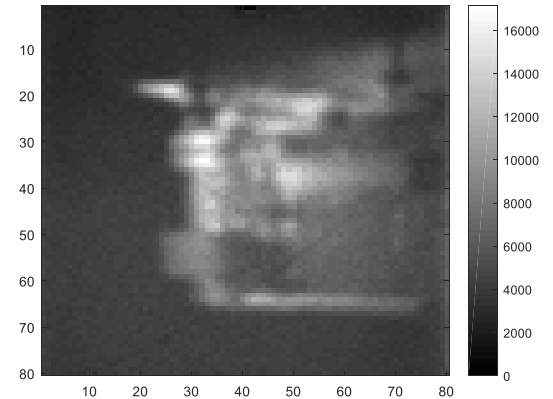
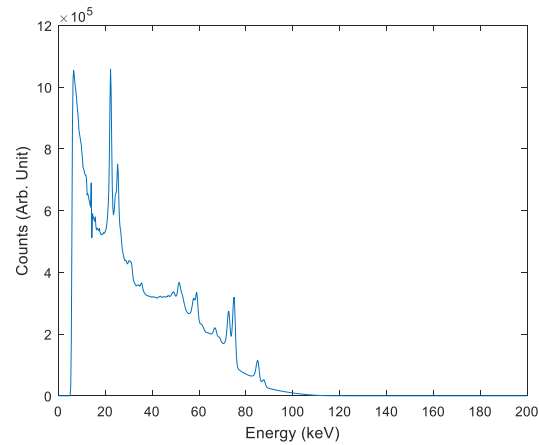




## - 유약분석 결과

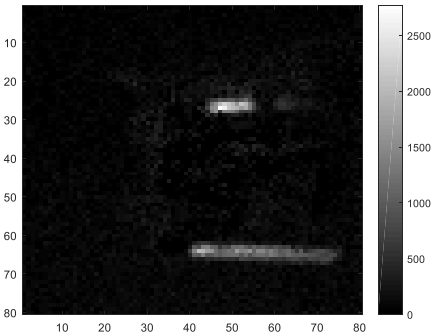
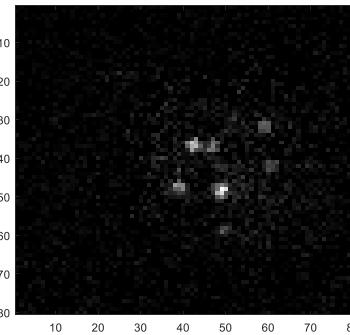
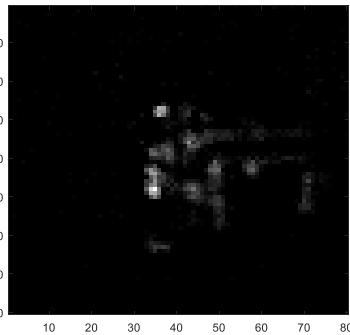
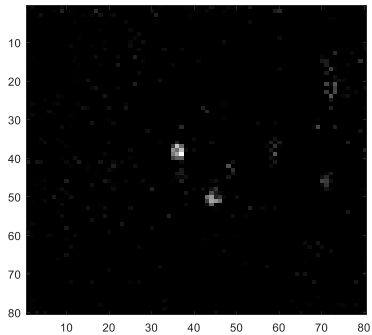
유약	구성성분
투명유	Ti, Zn, Ba, Pr
상아철	Ti, Fe, Ba, Gd
민트결정	Ti, Fe, Cu, Ba
진주유	Ti, Nb, Ba
옥색유	Ti, Nb
루호유백	Ti, Nb, Ba, Pr
백매트	Nb

## - 아두이노 회로 실험 결과



<전체 스펙트럼>

<전체 영상>



<Ag 영상>

<Sn 영상>

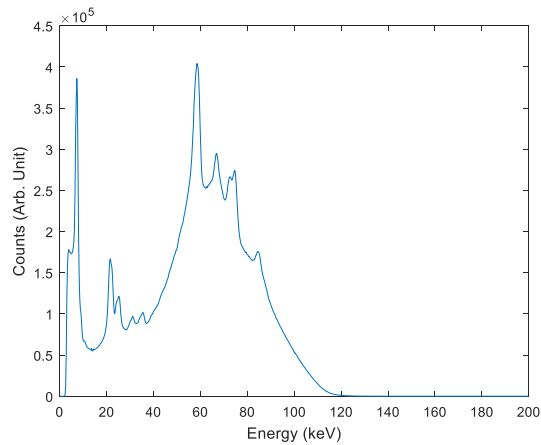
<Ba 영상>

<Sb 영상>

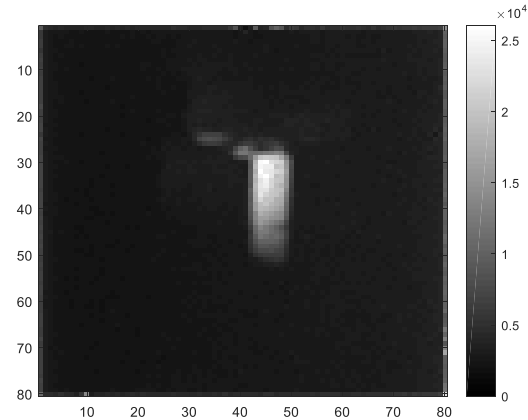
## Gold ???



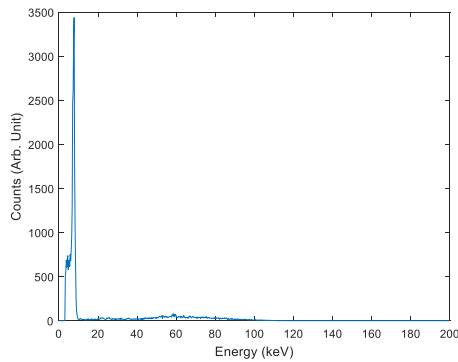
## - Purse clip



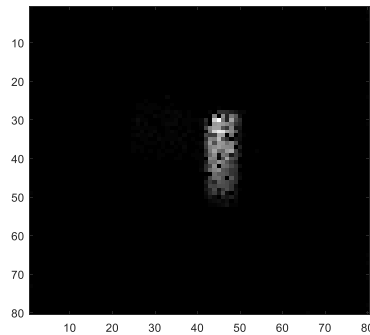
〈전체 스펙트럼〉



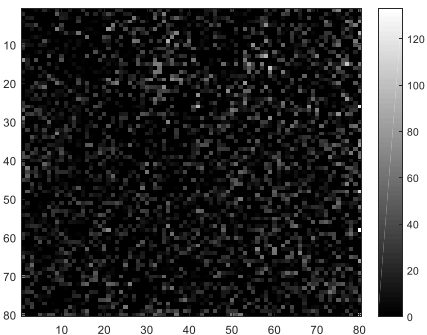
〈전체 영상〉



〈픽셀 스펙트럼〉

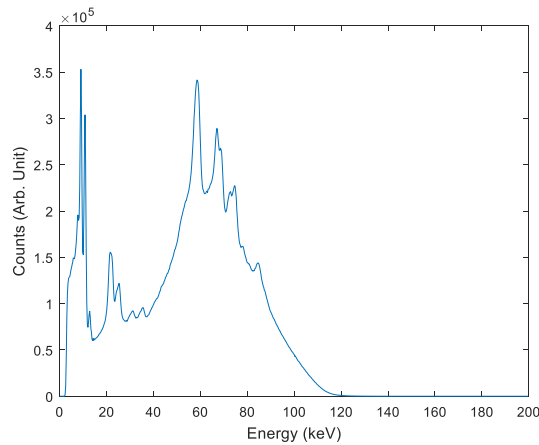


〈Cu 영상〉

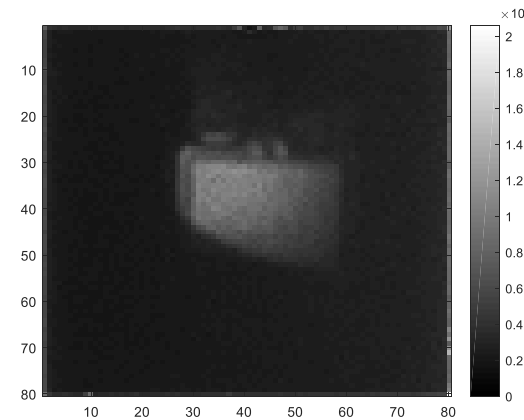


〈Au 영상〉

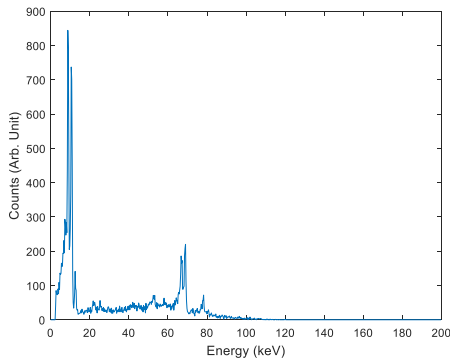
## - Gold Plate



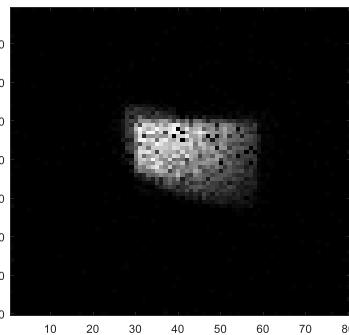
〈전체 스펙트럼〉



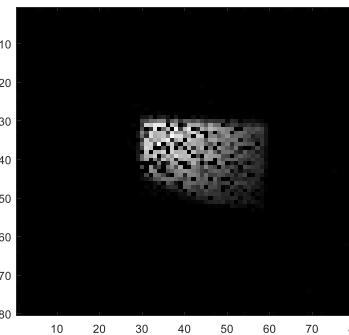
〈전체 영상〉



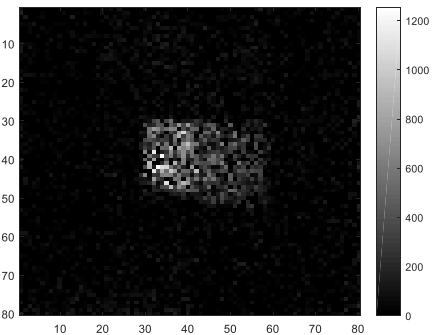
〈픽셀 스펙트럼〉



〈Ga 영상〉

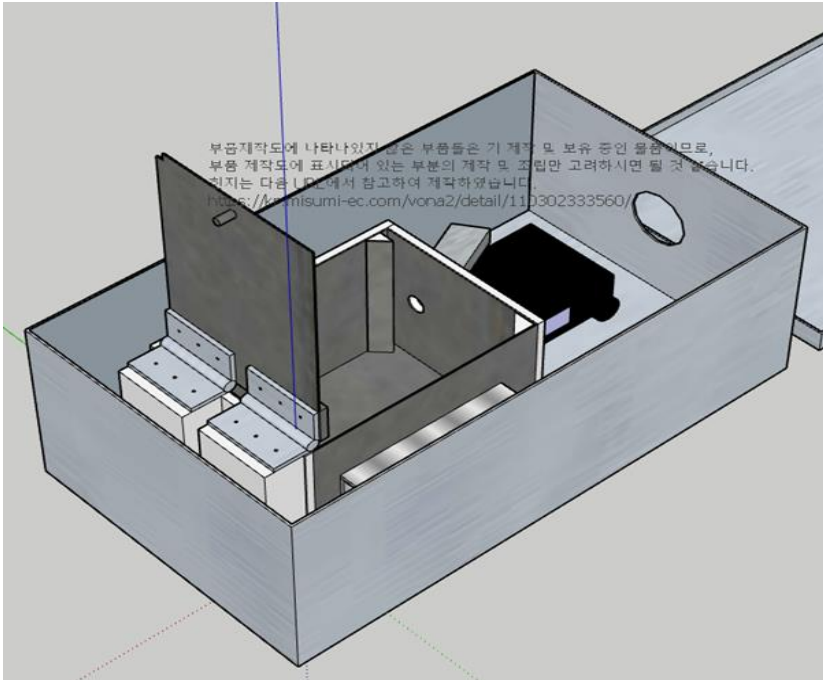


〈Se 영상〉



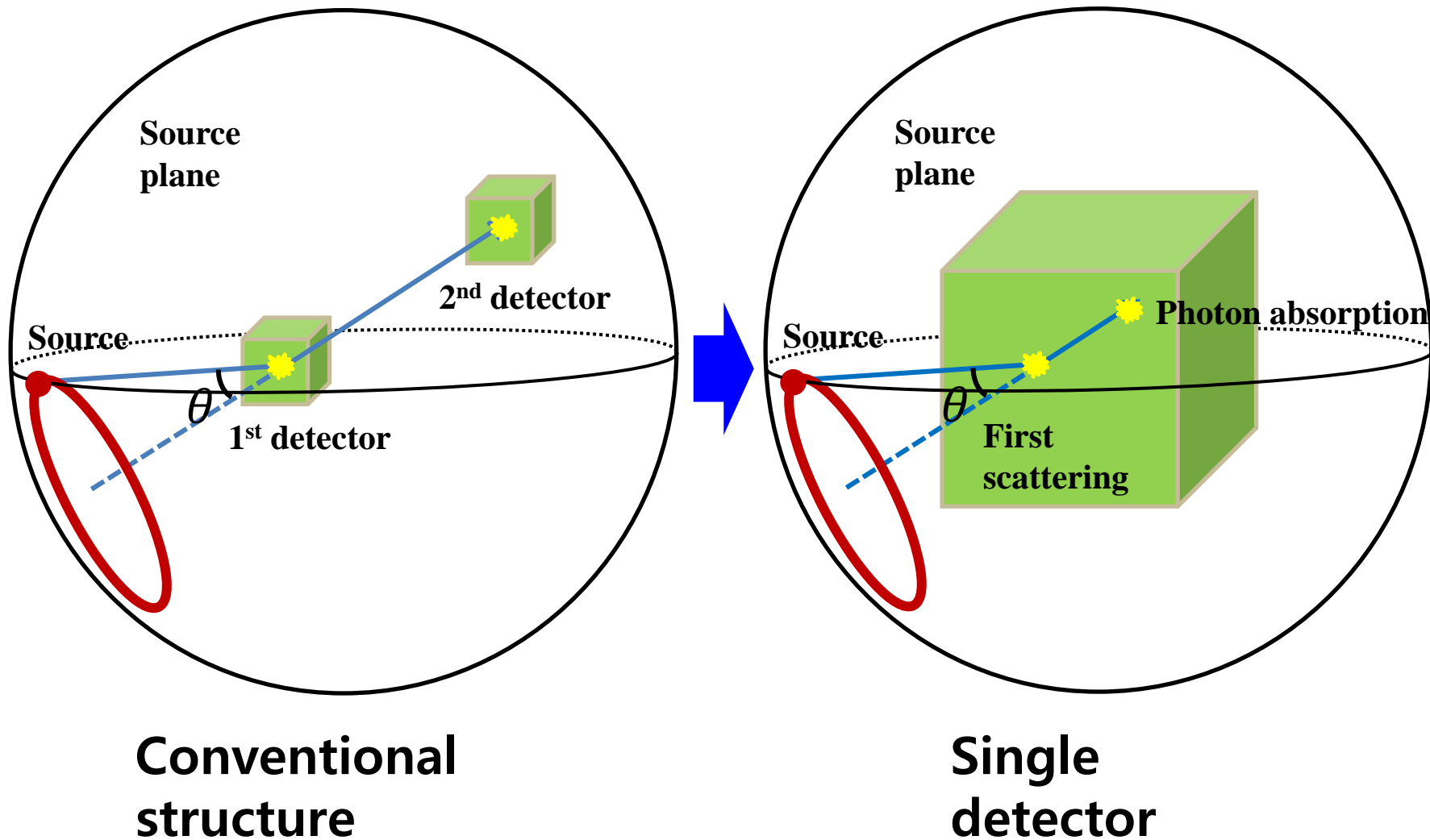
〈Au 영상〉

## - Mobile FXCT



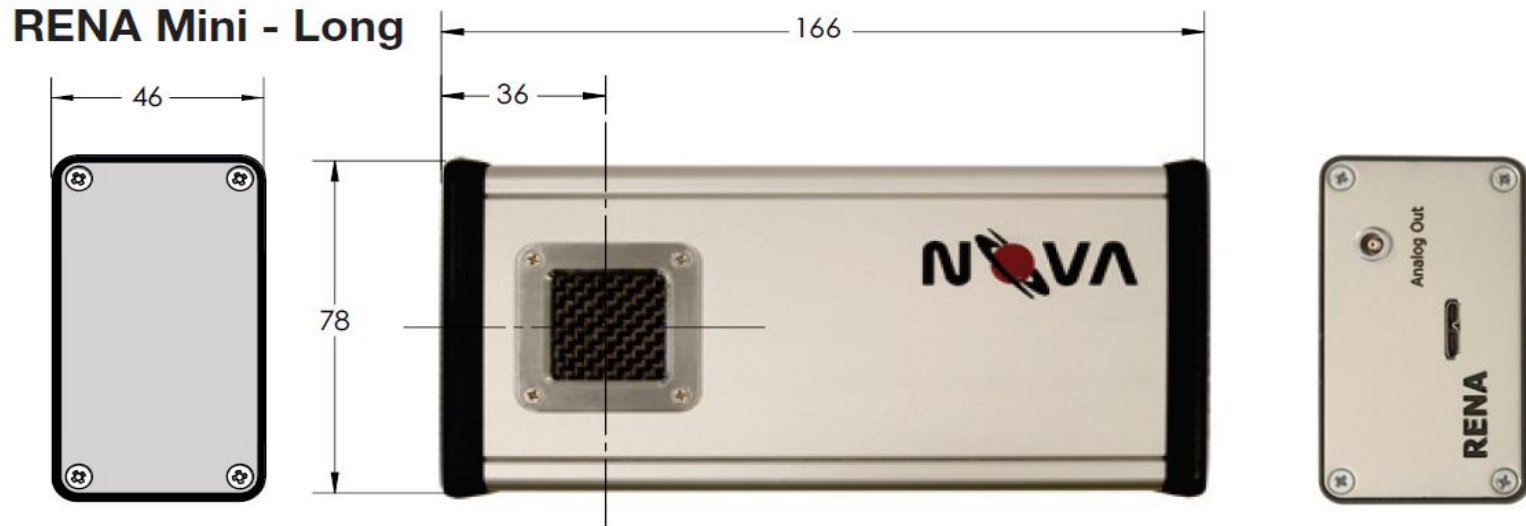
**Portable X-ray tube (50 kV), Field Application**

# CdZnTe $4\pi$ Compton Imager



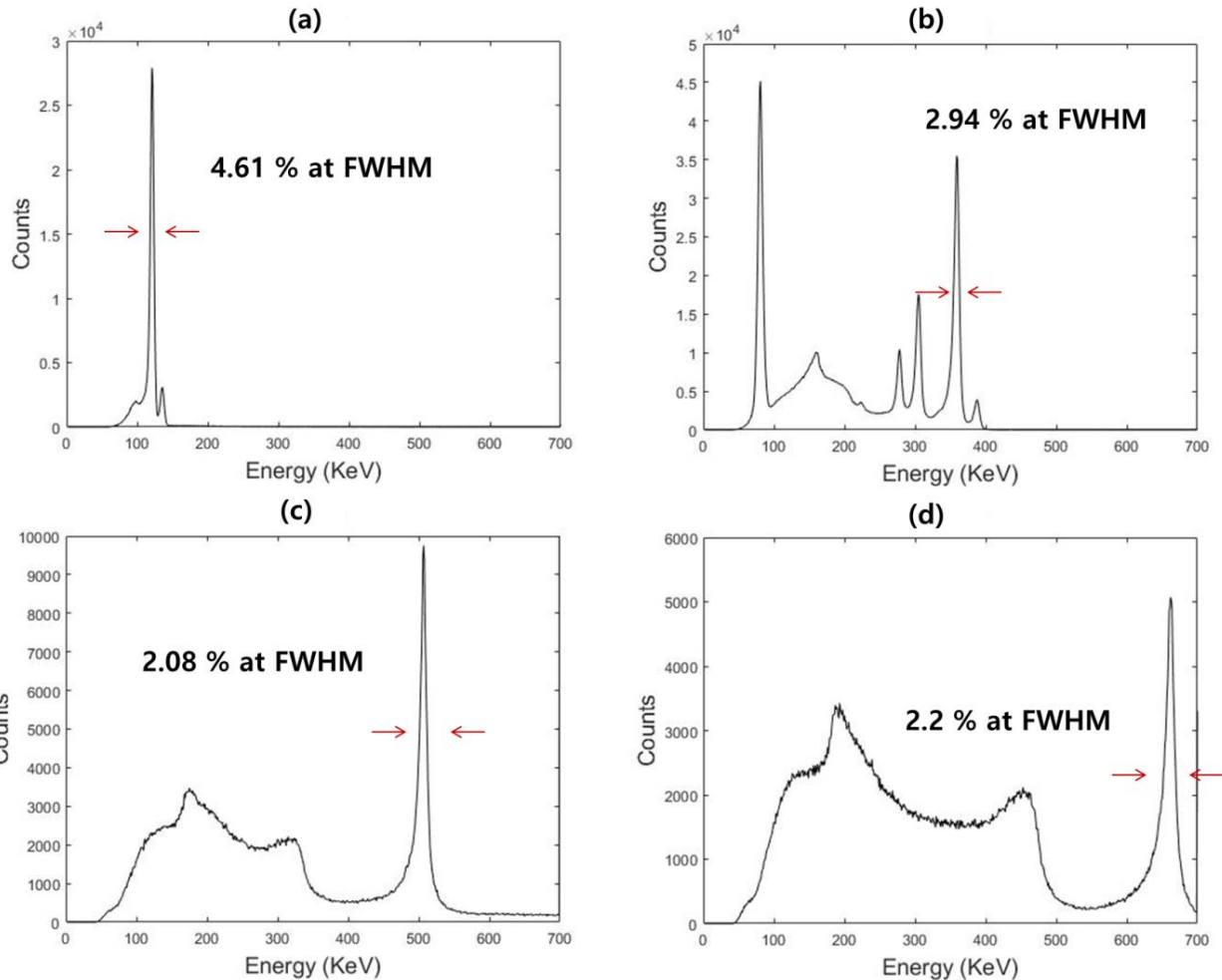


- **Rena-mini™ development kit with pixelated CZT from Kromek**

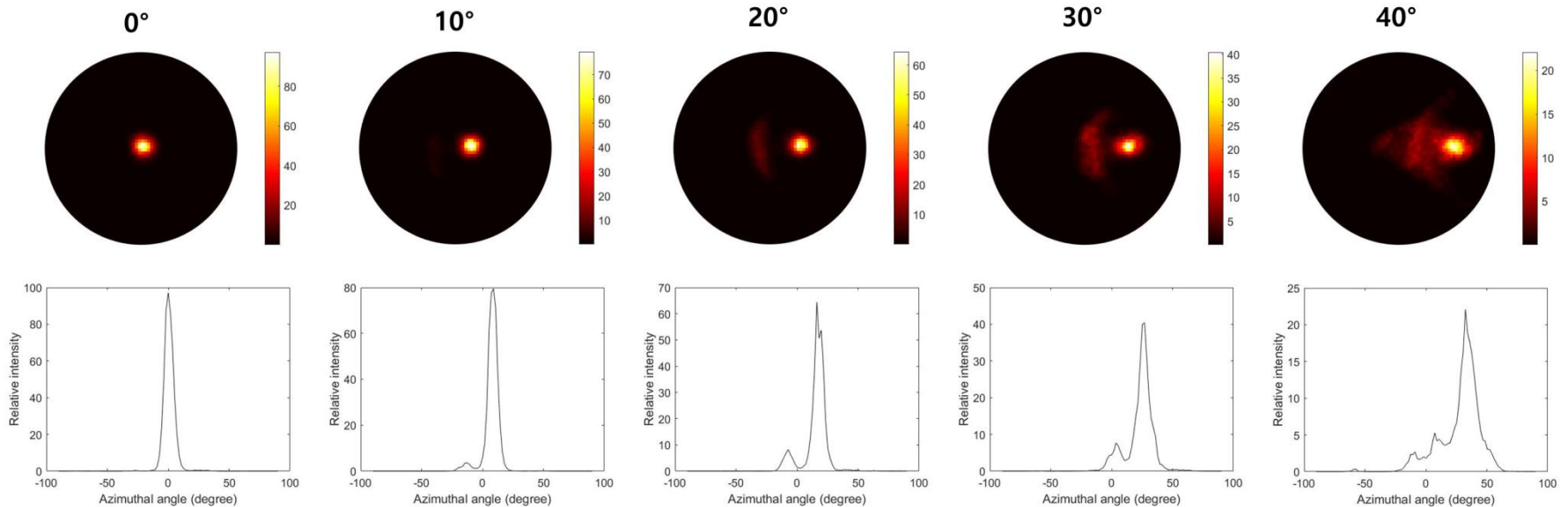


Parameter	Description/Value
Sensor type	Cadmium Zinc Telluride
Sensor size	20 mm × 20 mm × 5 mm (8 × 8 pixel pattern)
Energy range	20 keV - 3 MeV
Channel	64 channels for anode 1 channel for cathode (total 72 channels available)
Timing resolution	≤ 10 ns
Maximum count rate	10 <sup>5</sup> count/s
Power consumption	≤ 6 mW/channel

## Total energy spectrum after drift time correction

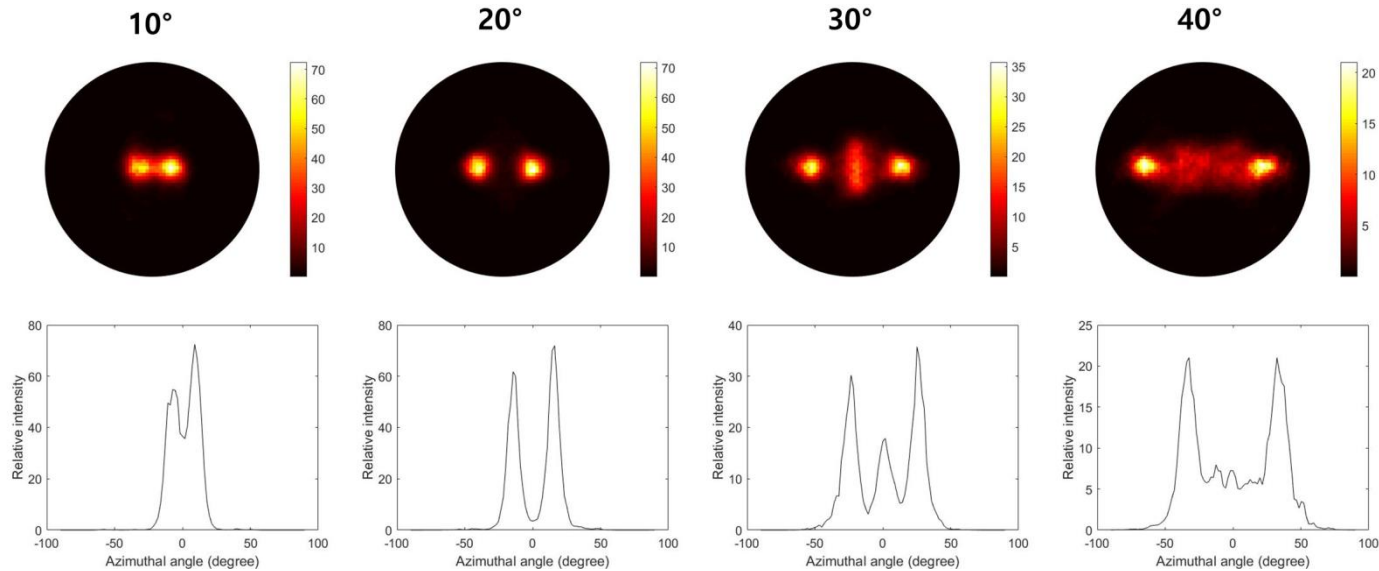


## Image reconstruction for offset source ( $^{137}\text{Cs}$ )



Offset angle	FWHM	Source position (ERROR)	Intrinsic efficiency
$0^\circ$	$8.15^\circ$	$0^\circ$ (0%)	$6.70 \times 10^{-4}$
$10^\circ$	$8.37^\circ$	$9^\circ$ (10%)	$6.11 \times 10^{-4}$
$20^\circ$	$8.51^\circ$	$16.2^\circ$ (19%)	$6.15 \times 10^{-4}$
$30^\circ$	$9.00^\circ$	$27^\circ$ (10%)	$5.84 \times 10^{-4}$
$40^\circ$	$12.74^\circ$	$32.4^\circ$ (19%)	$5.83 \times 10^{-4}$

## Image reconstruction for two $^{137}\text{Cs}$ sources

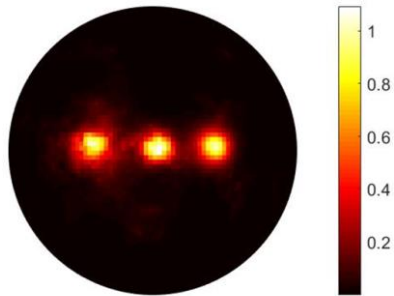


Offset angle	FWHM	Source position (ERROR)	Intrinsic efficiency
10°	8.10°	7.2° (28%)	$7.11 \times 10^{-4}$
	7.58°	9° (10%)	
20°	8.13°	14.4° (28%)	$7.07 \times 10^{-4}$
	7.54°	16.2° (19%)	
30°	7.56°	23.4° (22%)	$5.76 \times 10^{-4}$
	7.20°	25.2° (16%)	
40°	7.66°	32.4° (19%)	$4.87 \times 10^{-4}$
	7.04°	32.4° (19%)	

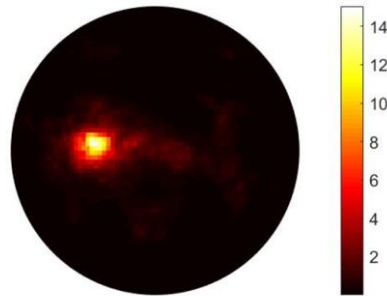
# CdZnTe $4\pi$ Compton Imager

## Image reconstruction for multiple sources (Simultaneous measurement)

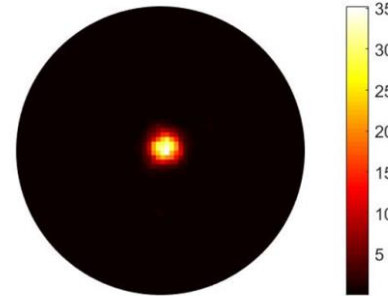
all



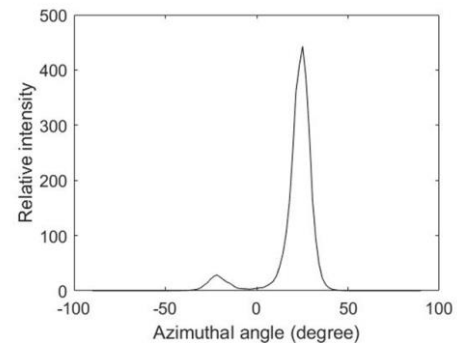
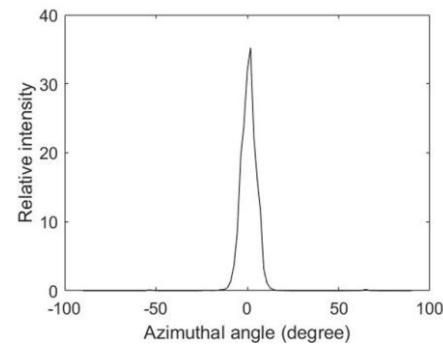
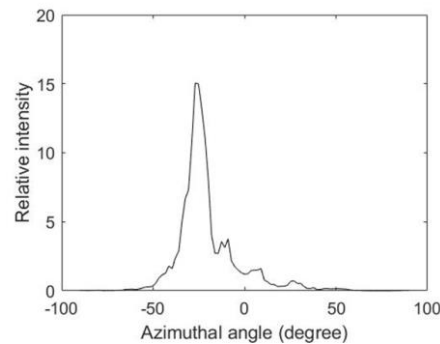
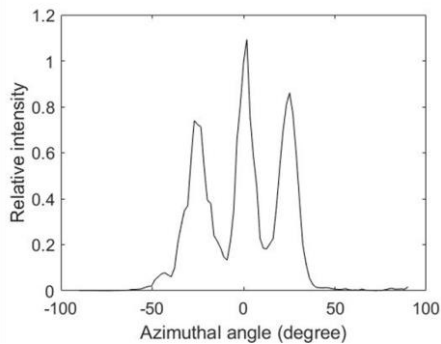
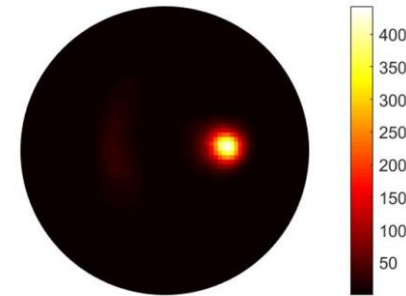
$^{22}\text{Na}$



$^{137}\text{Cs}$



$^{133}\text{Ba}$

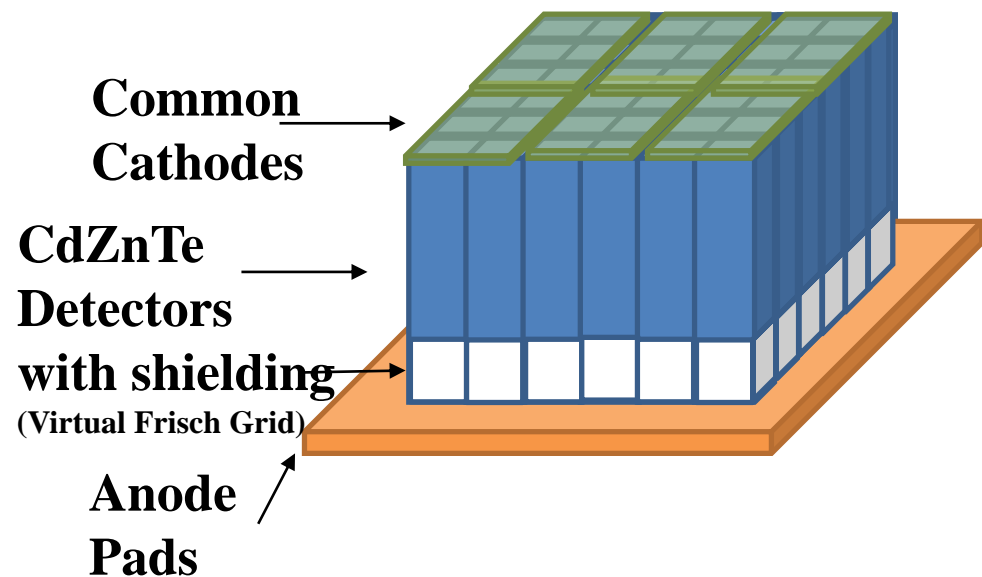


# CdZnTe $4\pi$ Compton Imager

It is difficult to make a very large one. ( $>6 \text{ cm}^3$ )

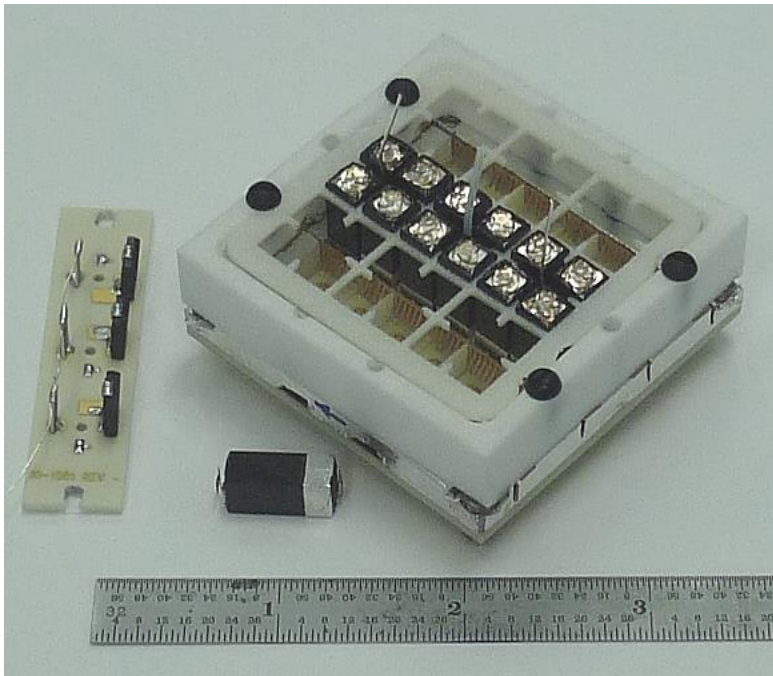
But it is easy make a small one.  
( $\cong 0.5 \text{ cm}^3$ )

and **Make a Large Array by Segmentation!** ( $\cong 20 \text{ cm}^3$ )  
with specialized electrodes

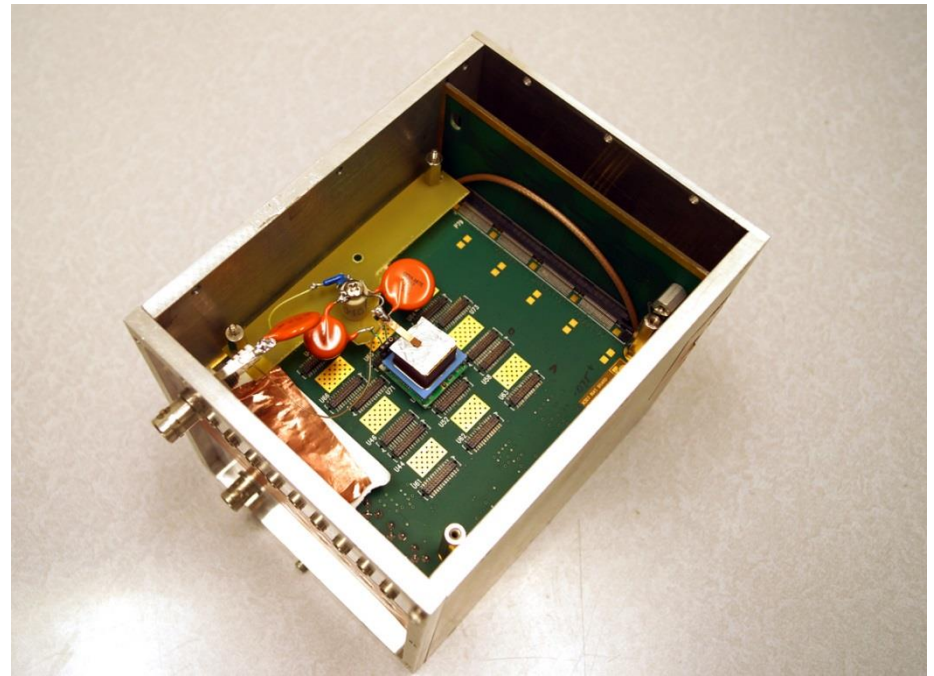


# CdZnTe $4\pi$ Compton Imager

**BNL**



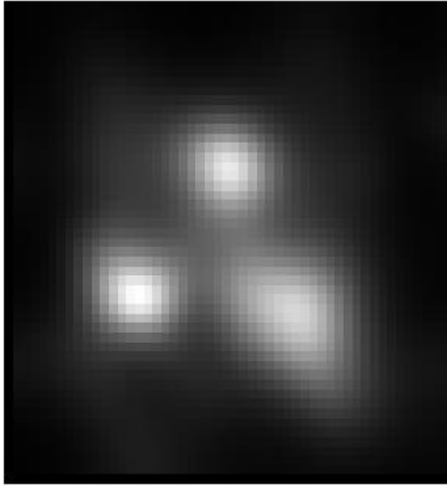
**Detector Array**



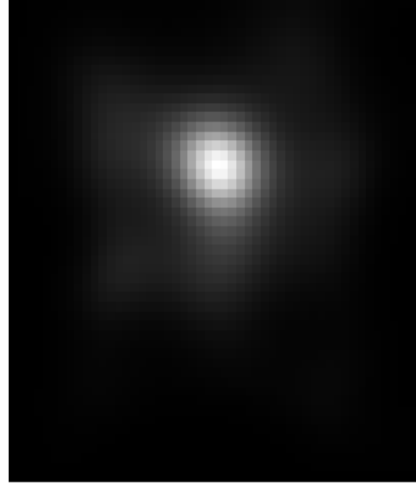
**ASIC and HV connection**

# CdZnTe $4\pi$ Compton Imager

All  
Three  
Sources

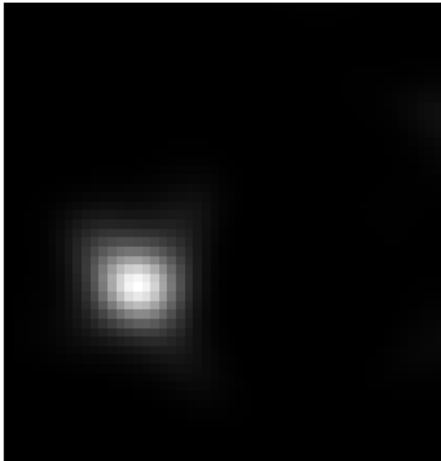


$^{137}\text{Cs}$   
(662 keV)

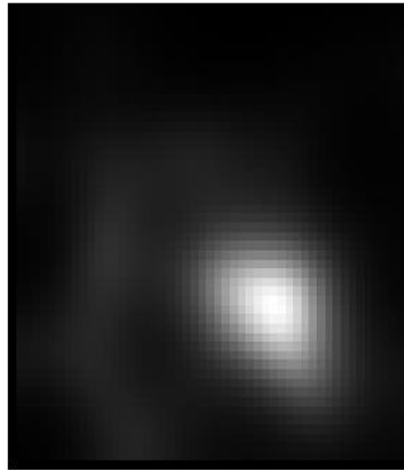


MLEM, 50<sup>th</sup> Iteration  
50° between sources

$^{60}\text{Co}$   
(1173,  
1332 keV)



$^{133}\text{Ba}$   
(356 keV)





# CdZnTe $4\pi$ Compton Imager



**1. Furnace**



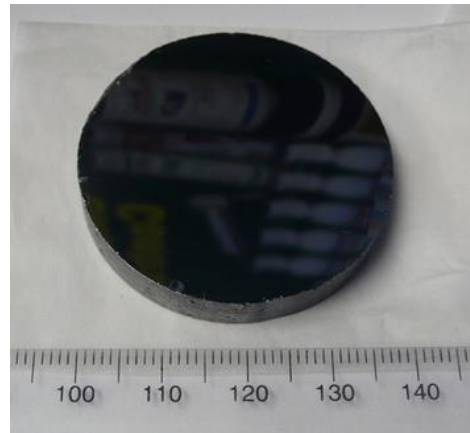
**2. Ingot**



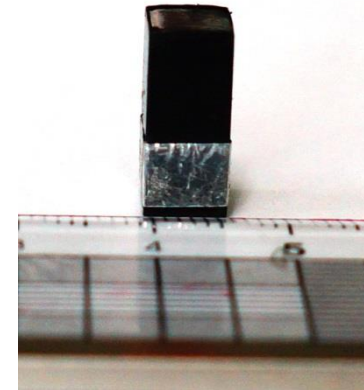
**3. Wire Sawing**



**4. Polishing**

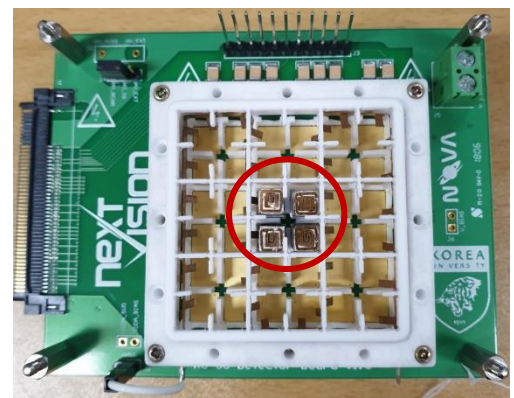
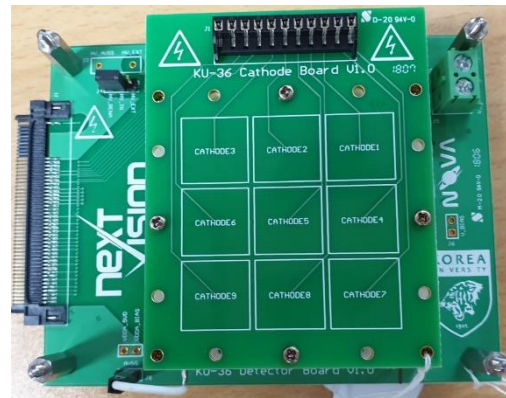
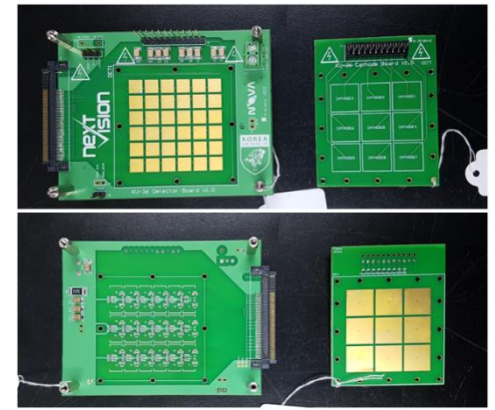
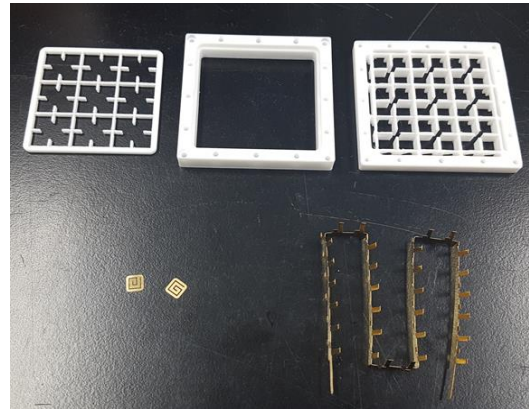
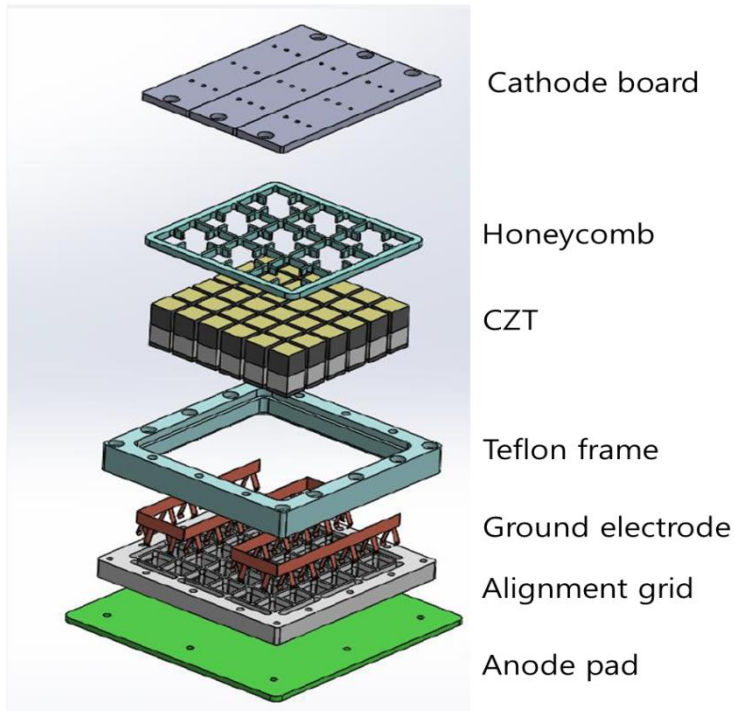


**5. Wafer**



**6. Detector (15mm)**

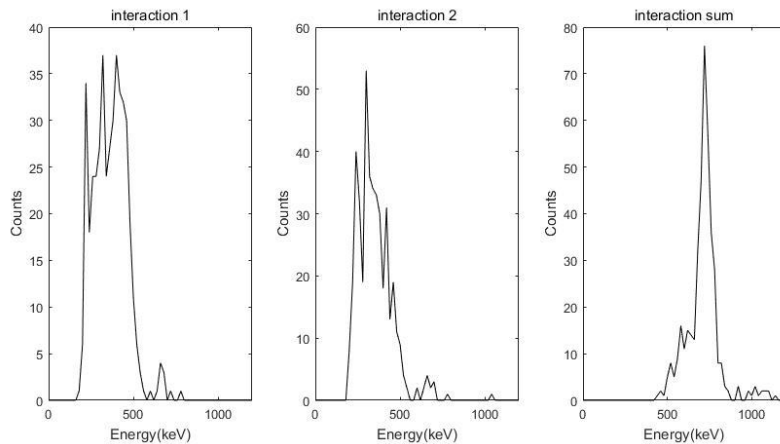
# CdZnTe $4\pi$ Compton Imager



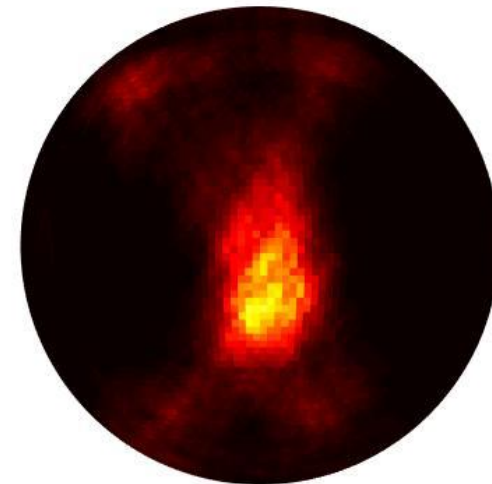
**Schematic Diagram**

**Assembled System**

## Assembled System



**Energy Spectrums**  
(1<sup>st</sup> 2<sup>nd</sup> and Sum events)



**$4\pi$  Reconstructed Image**  
(Side exposure, 10 min, 10  $\mu$ Ci, 5 cm)

- **Detection system is a Base for Radiation Application**
- **Researches for Detection System in Korea**
- **Current Research in RMI of Korea Univ.**
- **Specially Demanding Points in Korea Technology**
  - **Detector Material**
  - **Analog Signal Integrated Circuit (ASIC)**
  - **More than 20 – 30 years of Research on the Topics**
    - . **Compete with Small but Strong Companies**
    - . **Domestic Market is limited**

**Solution?**

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## ● Solution?

### ■ Continuous Support

- World Leading Small Companies needs **>30 years**
- **Technician** as well as **Idea**
- **Venture (Startup) Companies (Univ.)**

### ■ Cooperation

- Academy-Research-Industry
  - Connection between Researchers
  - No Negative Competition <- Large Gross Sum
  - International Research
-